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About Cypress
Cypress (NASDAQ: CY) delivers high-performance, high-quality solutions at the heart of today's most advanced embedded systems, from automotive, industrial and networking platforms to highly interactive consumer and mobile devices. With a broad, differentiated product portfolio that includes NOR flash memories, F-RAM™ and SRAM, Traveo™ microcontrollers, the industry's only PSoC® programmable system-on-chip solutions, analog and PMIC Power Management ICs, CapSense® capacitive touch-sensing controllers, and Wireless BLE Bluetooth® Low-Energy and USB connectivity solutions, Cypress is committed to providing its customers worldwide with consistent innovation, best-in-class support and exceptional system value.

FUJITSU SEMICONDUCTOR
DATA SHEET

DS07-13750-4E

16-bit Microcontroller

CMOS

F²MC-16LX MB90920 Series

MB90F922NC/F922NCS/922NCS/F923NC/F923NCS/ MB90F924NC/F924NCS/V920-101/V920-102

■ DESCRIPTION

The MB90920 series is a family of general-purpose FUJITSU SEMICONDUCTOR 16-bit microcontrollers designed for applications such as vehicle instrument panel control.

The instruction set retains the AT architecture from the F²MC-8L and F²MC-16LX families, with further refinements including high-level language instructions, extended addressing modes, improved multiplication and division operations (signed), and bit processing. In addition, long word processing is made possible by the inclusion of a built-in 32-bit accumulator.

Note : F²MC is the abbreviation of FUJITSU Flexible Microcontroller.

■ FEATURES

- Clock
  Built-in PLL clock frequency multiplication circuit.
  Selection of machine clocks (PLL clocks) is allowed among frequency division by two on oscillation clock, and multiplication of 1 to 8 times of oscillation clock (for 4 MHz oscillation clock, 4 MHz to 32 MHz).
  Operation by sub clock (up to 50 kHz : 100 kHz oscillation clock divided by two) is allowed.
- 16-bit input capture (8 channels)
  Detects rising, falling, or both edges.
  16-bit capture register × 8
  The value of a 16-bit free-run timer counter is latched upon detection of an edge input to pin and an interrupt request is generated.

(Continued)

For the information for microcontroller supports, see the following web site.
This web site includes the **"Customer Design Review Supplement"** which provides the latest cautions on system development and the minimal requirements to be checked to prevent problems before the system development.

http://edevice.fujitsu.com/micom/en-support/

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2010.9

(Continued)

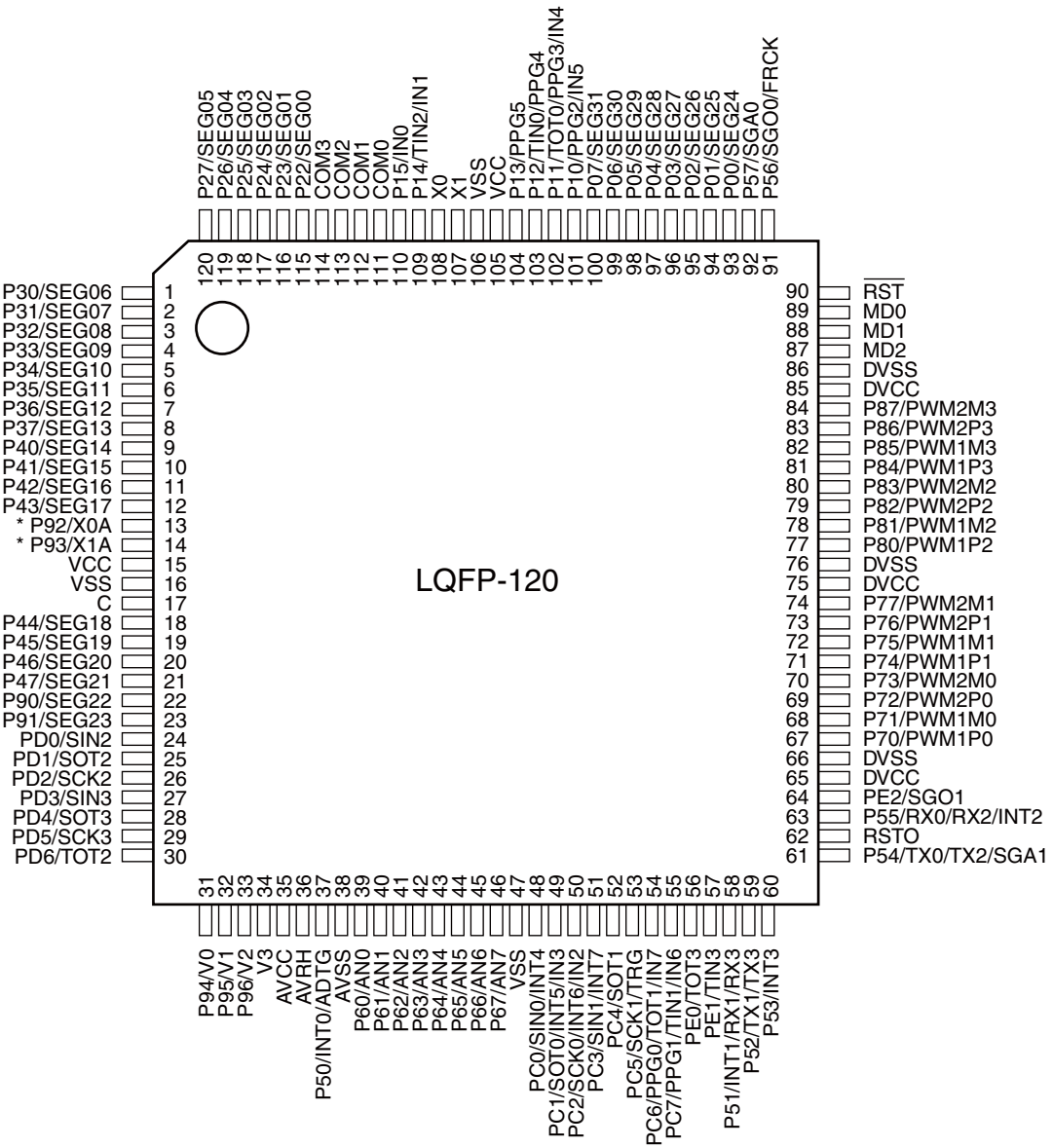
- 16-bit reload timer (4 channels)
  16-bit reload timer operation (select toggle output or one-shot output)
  Selectable event count function
- Real time watch timer (main clock)
  Operates directly from oscillator clock.
  Interrupt can be generated by second/minute/hour/date counter overflow.
- PPG timer (6 channels)
  Output pins (3 channels), external trigger input pin (1 channel)
  Operation clock frequencies : f_{CP}, $f_{CP}/2^2$, $f_{CP}/2^4$, $f_{CP}/2^6$
- Delay interrupt
  Generates interrupt for task switching.
  Interrupts to CPU can be generated/cleared by software setting.
- External interrupts (8 channels)
  8-channel independent operation
  Interrupt source setting available : “L” to “H” edge/ “H” to “L” edge/ “L” level/ “H” level.
- 8/10-bit A/D converter (8 channels)
  Conversion time : 3 µs (at f_{CP} = 32 MHz)
  External trigger activation available (P50/INT0/ADTG)
  Internal timer activation available (16-bit reload timer 1)
- UART(LIN/SCI) (4 channels)
  Equipped with full duplex double buffer
  Clock-asynchronous or clock-synchronous serial transfer is available
- CAN interface (4 channels : CAN0 and CAN2, and CAN1 and CAN3 share transmission and reception pins, and interrupt control registers).
  Conforms to CAN specifications version 2.0 Part A and B.
  Automatic resend in case of error.
  Automatic transfer in response to remote frame.
  16 prioritized message buffers for data and ID
  Multiple message support
  Flexible configuration for receive filter : Full bit compare/full bit mask/two partial bit masks
  Supports up to 1 Mbps
  CAN wakeup function (RX connected to INT0 internally)
- LCD controller/driver (32 segment x 4 common)
  Segment driver and command driver with direct LCD panel (display) drive capability
- Reset on detection of low voltage/program loop
  Automatic reset when low voltage is detected
  Program looping detection function
- Stepping motor controller (4 channels)
  High current output for each channel × 4
  Synchronized 8/10-bit PWM for each channel × 2
- Sound generator (2 channels)
  8-bit PWM signal mixed with tone frequency from 8-bit reload counter.
  PWM frequencies : 125 kHz, 62.5 kHz, 31.2 kHz, 15.6 kHz (at f_{CP} = 32 MHz)
  Tone frequencies : PWM frequency /2/ , divided by (reload frequency +1)
- Input/output ports
  General-purpose input/output port (CMOS output) 93 ports
- Function for port input level selection
  Automotive/CMOS-Schmitt
- Flash memory security function
  Protects the contents of Flash memory (Flash memory product only)

■ PRODUCT LINEUP

Part number / Parameter	MB90 F922NC	MB90 F922NCS	MB90 F923NC	MB90 F923NCS	MB90 F924NC	MB90 F924NCS	MB90 922NCS	MB90 V920-101	MB90 V920-102
Type	Flash memory product						MASK ROM product	Evaluation product	
CPU	F^2MC-16LX CPU								
System clock	PLL clock multiplier circuit (× 1, × 2, × 3, × 4, × 8, 1/2 when PLL stopped) Minimum instruction execution time 31.25 ns (with 4 MHz oscillation clock × 8)								
Sub clock pins (X0A, X1A)	Yes	No	Yes	No	Yes	No	No	No	Yes
ROM	Flash memory 256 Kbytes		Flash memory 384 Kbytes		Flash memory 512 Kbytes		256 K bytes	External	
RAM	10 Kbytes		16 Kbytes		24 Kbytes		10 K bytes	30 Kbytes	
I/O port	91 ports	93 ports	91 ports	93 ports	91 ports	93 ports	93 ports	93 ports	91 ports
LCD controller	32 segment × 4 common								
LIN-UART	UART (LIN/SCI) 4 channels								
CAN interface	4 channels								
16-bit input capture	8 channels								
16-bit reload timer	4 channels								
16-bit free-run timer	1 channel								
Real time watch timer	1 channel								
16-bit PPG timer	6 channels								
External interrupt	8 channels								
8/10-bit A/D converter	8 channels								
Low-voltage/ CPU operating detection reset	Yes							No	
Stepping motor controller	4 channels								
Sound generator	2 channels								
Flash memory security	Yes						—		
Operating voltage	4.0 V to 5.5 V							4.5 V to 5.5 V	
Package	LQFP-120							PGA-299	

■ PIN ASSIGNMENT

(TOP VIEW)



(FPT-120P-M21)

* : MB90V920-101, MB90F922NCS,MB90F923NCS,MB90F924NCS,MB90922NCS : P92, P93
MB90V920-102, MB90F922NC,MB90F923NC,MB90F924NC : X0A, X1A

■ PIN DESCRIPTIONS

Pin no.	Pin name	I/O circuit type*1	Function
108	X0	A	High-speed oscillation input pin
107	X1		High-speed oscillation output pin
13	X0A	B	Low-speed oscillation input pin
	P92	I	General-purpose I/O port
14	X1A	B	Low-speed oscillation output pin
	P93	I	General-purpose I/O port
90	$\overline{\text{RST}}$	C	Reset input pin
93	P00	F	General-purpose I/O port
	SEG24		LCD controller/driver segment output pin
94	P01	F	General-purpose I/O port
	SEG25		LCD controller/driver segment output pin
95	P02	F	General-purpose I/O port
	SEG26		LCD controller/driver segment output pin
96	P03	F	General-purpose I/O port
	SEG27		LCD controller/driver segment output pin
97	P04	F	General-purpose I/O port
	SEG28		LCD controller/driver segment output pin
98	P05	F	General-purpose I/O port
	SEG29		LCD controller/driver segment output pin
99	P06	F	General-purpose I/O port
	SEG30		LCD controller/driver segment output pin
100	P07	F	General-purpose I/O port
	SEG31		LCD controller/driver segment output pin
101	P10	I	General-purpose I/O port
	PPG2		16-bit PPG ch.2 output pin
	IN5		Input capture ch.5 trigger input pin
102	P11	I	General-purpose I/O port
	TOT0		16-bit reload timer ch.0 TOT output pin
	PPG3		16-bit PPG ch.3 output pin
	IN4		Input capture ch.4 trigger input pin
103	P12	I	General-purpose I/O port
	TIN0		16-bit reload timer ch.0 TIN input pin
	PPG4		16-bit PPG ch.4 output pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
104	P13	I	General-purpose I/O port
	PPG5		16-bit PPG ch.5 output pin
109	P14	I	General-purpose I/O port
	TIN2		16-bit reload timer ch.2 TIN input pin
	IN1		Input capture ch.1 trigger input pin
110	P15	I	General-purpose I/O port
	IN0		Input capture ch.0 trigger input pin
111	COM0	P	LCD controller/driver common output pin
112	COM1	P	LCD controller/driver common output pin
113	COM2	P	LCD controller/driver common output pin
114	COM3	P	LCD controller/driver common output pin
115	P22	F	General-purpose I/O port
	SEG00		LCD controller/driver segment output pin
116	P23	F	General-purpose I/O port
	SEG01		LCD controller/driver segment output pin
117	P24	F	General-purpose I/O port
	SEG02		LCD controller/driver segment output pin
118	P25	F	General-purpose I/O port
	SEG03		LCD controller/driver segment output pin
119	P26	F	General-purpose I/O port
	SEG04		LCD controller/driver segment output pin
120	P27	F	General-purpose I/O port
	SEG05		LCD controller/driver segment output pin
1	P30	F	General-purpose I/O port
	SEG06		LCD controller/driver segment output pin
2	P31	F	General-purpose I/O port
	SEG07		LCD controller/driver segment output pin
3	P32	F	General-purpose I/O port
	SEG08		LCD controller/driver segment output pin
4	P33	F	General-purpose I/O port
	SEG09		LCD controller/driver segment output pin
5	P34	F	General-purpose I/O port
	SEG10		LCD controller/driver segment output pin
6	P35	F	General-purpose I/O port
	SEG11		LCD controller/driver segment output pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
7	P36	F	General-purpose I/O port
	SEG12		LCD controller/driver segment output pin
8	P37	F	General-purpose I/O port
	SEG13		LCD controller/driver segment output pin
9	P40	F	General-purpose I/O port
	SEG14		LCD controller/driver segment output pin
10	P41	F	General-purpose I/O port
	SEG15		LCD controller/driver segment output pin
11	P42	F	General-purpose I/O port
	SEG16		LCD controller/driver segment output pin
12	P43	F	General-purpose I/O port
	SEG17		LCD controller/driver segment output pin
18	P44	F	General-purpose I/O port
	SEG18		LCD controller/driver segment output pin
19	P45	F	General-purpose I/O port
	SEG19		LCD controller/driver segment output pin
20	P46	F	General-purpose I/O port
	SEG20		LCD controller/driver segment output pin
21	P47	F	General-purpose I/O port
	SEG21		LCD controller/driver segment output pin
37	P50	I	General-purpose I/O port
	INT0		INT0 external interrupt input pin
	ADTG		A/D converter external trigger input pin
58	P51	I	General-purpose I/O port
	INT1		INT1 external interrupt input pin
	RX1		CAN interface 1 RX input pin
	RX3		CAN interface 3 RX input pin
59	P52	I	General-purpose I/O port
	TX1		CAN interface 1 TX output pin
	TX3		CAN interface 3 TX output pin
60	P53	I	General-purpose I/O port
	INT3		INT3 external interrupt input pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
61	P54	I	General-purpose I/O port
	TX0		CAN interface 0 TX output pin
	TX2		CAN interface 2 TX output pin
	SGA1		Sound generator ch.1 SGA output pin
63	P55	I	General-purpose I/O port
	RX0		CAN interface 0 RX input pin
	RX2		CAN interface 2 RX input pin
	INT2		INT2 external interrupt input pin
91	P56	I	General-purpose I/O port
	SGO0		Sound generator ch.0 SGO output pin
	FRCK		Free-run timer clock input pin
92	P57	I	General-purpose I/O port
	SGA0		Sound generator ch.0 SGA output pin
39	P60	H	General-purpose I/O port
	AN0		A/D converter input pin
40	P61	H	General-purpose I/O port
	AN1		A/D converter input pin
41	P62	H	General-purpose I/O port
	AN2		A/D converter input pin
42	P63	H	General-purpose I/O port
	AN3		A/D converter input pin
43	P64	H	General-purpose I/O port
	AN4		A/D converter input pin
44	P65	H	General-purpose I/O port
	AN5		A/D converter input pin
45	P66	H	General-purpose I/O port
	AN6		A/D converter input pin
46	P67	H	General-purpose I/O port
	AN7		A/D converter input pin
67	P70	L	General-purpose output-only port
	PWM1P0		Stepping motor controller ch.0 output pin
68	P71	L	General-purpose output-only port
	PWM1M0		Stepping motor controller ch.0 output pin
69	P72	L	General-purpose output-only port
	PWM2P0		Stepping motor controller ch.0 output pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
70	P73	L	General-purpose output-only port
	PWM2M0		Stepping motor controller ch.0 output pin
71	P74	L	General-purpose output-only port
	PWM1P1		Stepping motor controller ch.1 output pin
72	P75	L	General-purpose output-only port
	PWM1M1		Stepping motor controller ch.1 output pin
73	P76	L	General-purpose output-only port
	PWM2P1		Stepping motor controller ch.1 output pin
74	P77	L	General-purpose output-only port
	PWM2M1		Stepping motor controller ch.1 output pin
77	P80	L	General-purpose output-only port
	PWM1P2		Stepping motor controller ch.2 output pin
78	P81	L	General-purpose output-only port
	PWM1M2		Stepping motor controller ch.2 output pin
79	P82	L	General-purpose output-only port
	PWM2P2		Stepping motor controller ch.2 output pin
80	P83	L	General-purpose output-only port
	PWM2M2		Stepping motor controller ch.2 output pin
81	P84	L	General-purpose output-only port
	PWM1P3		Stepping motor controller ch.3 output pin
82	P85	L	General-purpose output-only port
	PWM1M3		Stepping motor controller ch.3 output pin
83	P86	L	General-purpose output-only port
	PWM2P3		Stepping motor controller ch.3 output pin
84	P87	L	General-purpose output-only port
	PWM2M3		Stepping motor controller ch.3 output pin
22	P90	F	General-purpose I/O port
	SEG22		LCD controller/driver segment output pin
23	P91	F	General-purpose I/O port
	SEG23		LCD controller/driver segment output pin
31	P94	G	General-purpose I/O port
	V0		LCD controller/driver reference power supply pin
32	P95	G	General-purpose I/O port
	V1		LCD controller/driver reference power supply pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
33	P96	G	General-purpose I/O port
	V2		LCD controller/driver reference power supply pin
34	V3	—	LCD controller/driver reference power supply pin
48	PC0	J	General-purpose I/O port
	SIN0		UART ch.0 serial data input pin
	INT4		INT4 external interrupt input pin
49	PC1	I	General-purpose I/O port
	SOT0		UART ch.0 serial data output pin
	INT5		INT5 external interrupt input pin
	IN3		Input capture ch.3 trigger input pin
50	PC2	I	General-purpose I/O port
	SCK0		UART ch.0 serial clock I/O pin
	INT6		INT6 external interrupt input pin
	IN2		Input capture ch.2 trigger input pin
51	PC3	J	General-purpose I/O port
	SIN1		UART ch.1 serial data input pin
	INT7		INT7 external interrupt input pin
52	PC4	I	General-purpose I/O port
	SOT1		UART ch.1 serial data output pin
53	PC5	I	General-purpose I/O port
	SCK1		UART ch.1 serial clock I/O pin
	TRG		16-bit PPG ch.0 to ch.5 external trigger input pin
54	PC6	I	General-purpose I/O port
	PPG0		16-bit PPG ch.0 output pin
	TOT1		16-bit reload timer ch.1 TOT output pin
	IN7		Input capture ch.7 trigger input pin
55	PC7	I	General-purpose I/O port
	PPG1		16-bit PPG ch.1 output pin
	TIN1		16-bit reload timer ch.1 TIN input pin
	IN6		Input capture ch.6 trigger input pin
24	PD0	J	General-purpose I/O port
	SIN2		UART ch.2 serial data input pin
25	PD1	I	General-purpose I/O port
	SOT2		UART ch.2 serial data output pin

(Continued)

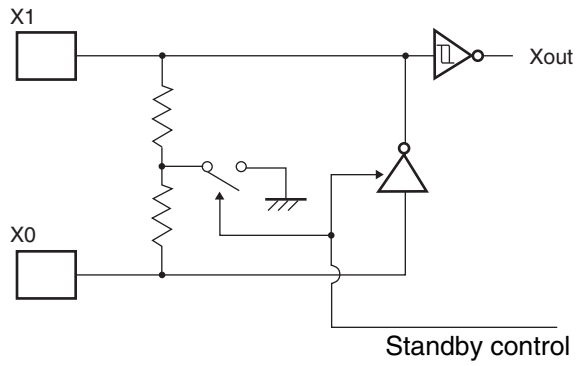
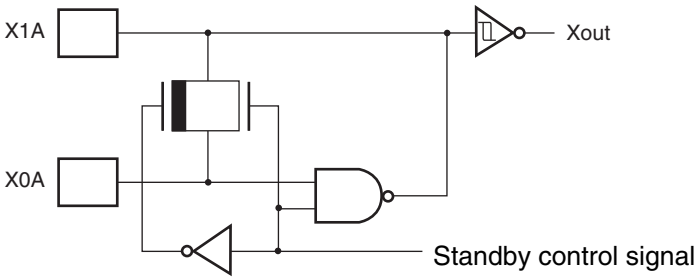
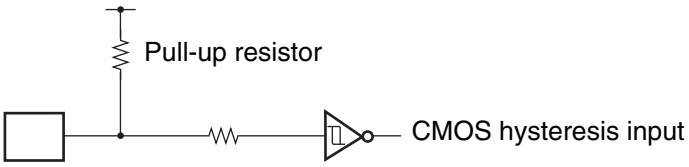
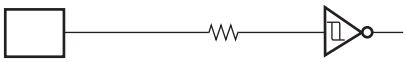
(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
26	PD2	I	General-purpose I/O port
	SCK2		UART ch.2 serial clock I/O pin
27	PD3	J	General-purpose I/O port
	SIN3		UART ch.3 serial data input pin
28	PD4	I	General-purpose I/O port
	SOT3		UART ch.3 serial data output pin
29	PD5	I	General-purpose I/O port
	SCK3		UART ch.3 serial clock I/O pin
30	PD6	I	General-purpose I/O port
	TOT2		16-bit reload timer ch.2 TOT output pin
56	PE0	I	General-purpose I/O port
	TOT3		16-bit reload timer ch.3 TOT output pin
57	PE1	I	General-purpose I/O port
	TIN3		16-bit reload timer ch.3 TIN input pin
64	PE2	I	General-purpose I/O port
	SGO1		Sound generator ch.1 SGO output pin
62	RSTO	N	Internal reset signal output pin
65, 75, 85	DVCC	—	Power supply input pins dedicated for high current output buffer
66, 76, 86	DVSS	—	Power supply GND pins dedicated for high current output buffer
35	AVCC	—	A/D converter dedicated power supply input pin
38	AVSS	—	A/D converter dedicated power supply GND pin
36	AVRH	—	A/D converter Vref+ input pin. Vref- is fixed to AVSS.
89	MD0	D	Mode setting input pin. Connect to VCC pin.
88	MD1	D	Mode setting input pin. Connect to VCC pin.
87	MD2	D/E*2	Mode setting input pin. Connect to VSS pin.
17	C	—	External capacitor pin. Connect a 0.1 μF capacitor between this pin and the VSS pin.
15, 105	VCC	—	Power supply input pins
16, 47, 106	VSS	—	GND power supply pins

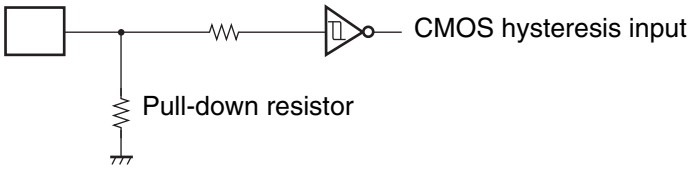
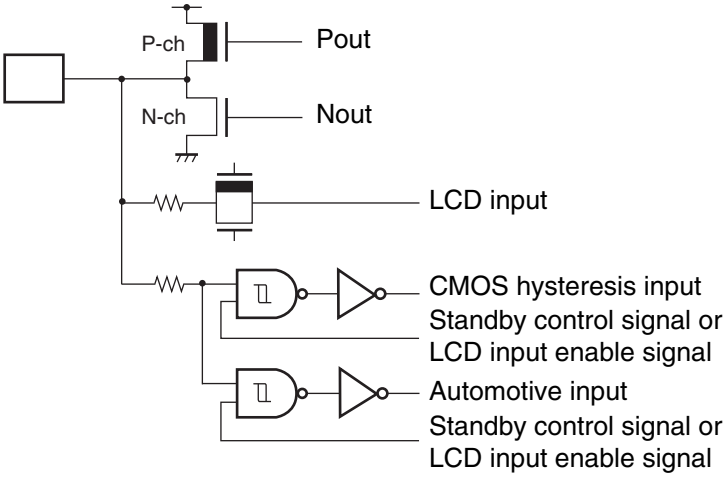
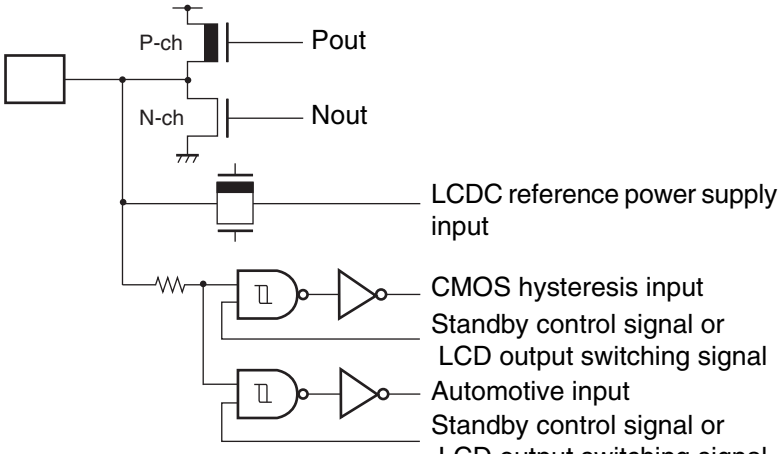
*1 : For I/O circuit type, refer to “ ■ I/O CIRCUIT TYPES”.

*2 : The I/O circuit type is D for Flash memory products and E for evaluation products.

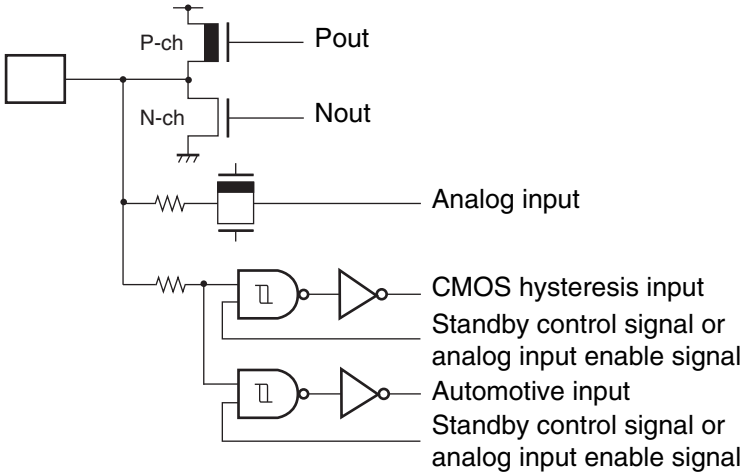
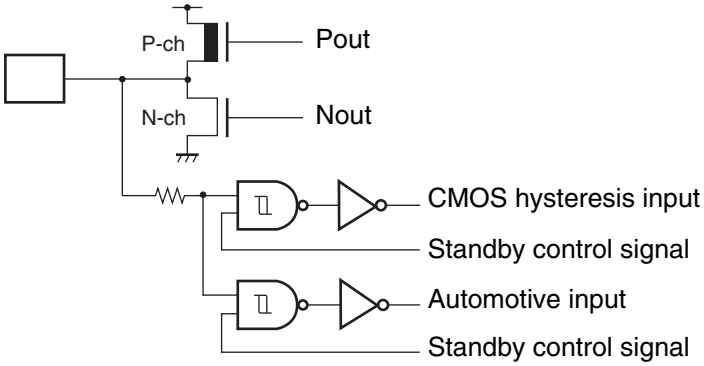
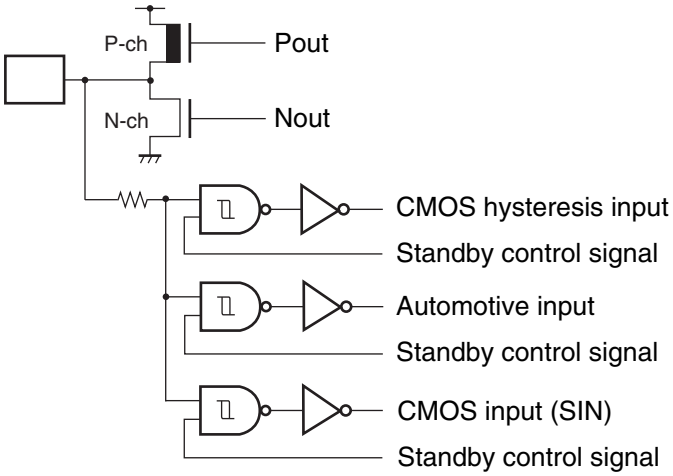
■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A		Oscillation circuit High-speed oscillation feedback resistance : approx. 1 MΩ (Flash memory product/MASK ROM product/Evaluation product)
B		Oscillation circuit Low-speed oscillation feedback resistance : approx. 10 MΩ
C		Input-only pin (with pull-up resistance) • Attached pull-up resistor : approx. 50 kΩ • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC})
D		Input-only pin • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) Note: The MD2 pin of the Flash memory products uses this circuit type.

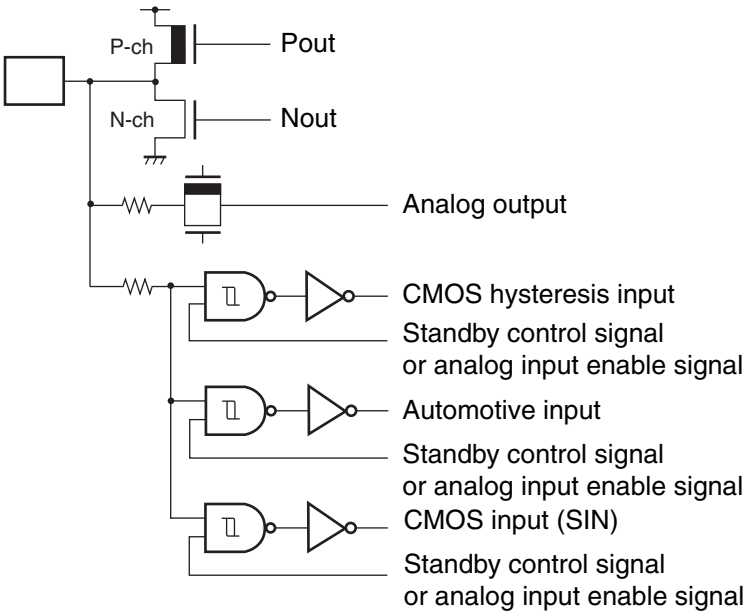
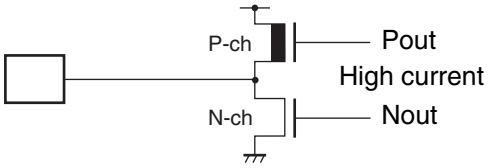
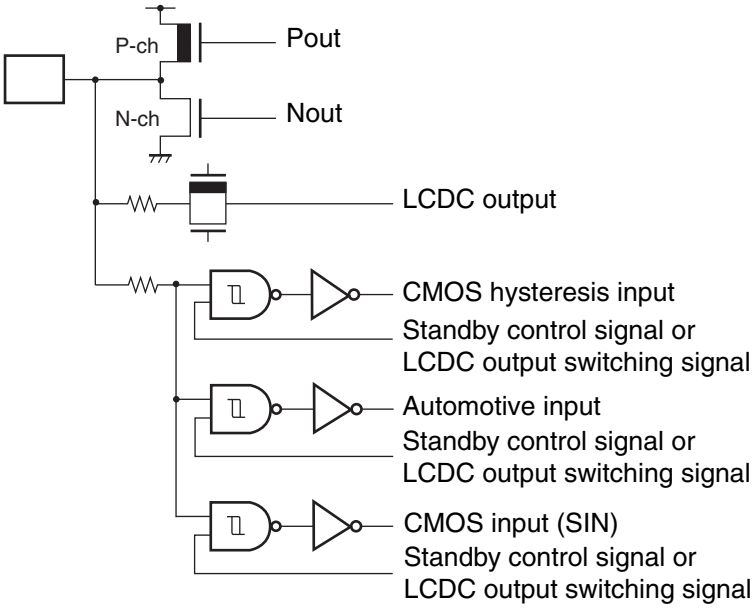
(Continued)

Type	Circuit	Remarks
E		Input-only pin (with pull-down resistance) • Attached pull-down resistance: approx. 50 kΩ • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) Note: The MD2 pin of the evaluation products uses this circuit type.
F		LCD output common general-purpose port • CMOS output (I_{OH}/I_{OL} = ±4 mA) • Hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
G		LCDC reference power supply common general-purpose port • CMOS output (I_{OH}/I_{OL} = ±4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})

(Continued)

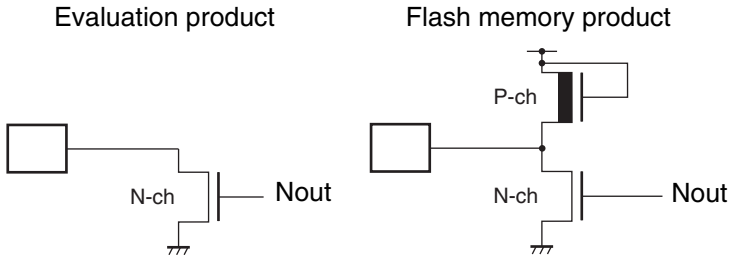
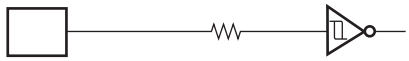
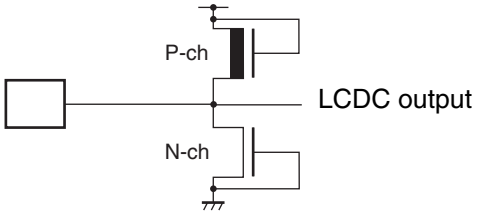
Type	Circuit	Remarks
H		A/D converter input common general-purpose port • CMOS output (I_{OH}/I_{OL} = ± 4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
I		General-purpose port • CMOS output (I_{OH}/I_{OL} = ± 4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
J		General-purpose port (serial input) • CMOS output (I_{OH}/I_{OL} = ± 4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • CMOS input (SIN) (V_{IH}/V_{IL} = 0.7 V_{CC}/0.3 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})

(Continued)

Type	Circuit	Remarks
K		A/D converter input common general-purpose port (serial input) • CMOS output (I_{OH}/I_{OL} = ± 4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • CMOS input (SIN) (V_{IH}/V_{IL} = 0.7 V_{CC}/0.3 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
L		High current output port (SMC pin) CMOS output (I_{OH}/I_{OL} = ± 30 mA)
M		LCDC output common general-purpose port (serial input)) • CMOS output (I_{OH}/I_{OL} = ± 4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • CMOS input (SIN) (V_{IH}/V_{IL} = 0.7 V_{CC}/0.3 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})

(Continued)

(Continued)

Type	Circuit	Remarks
N		N-ch open-drain pin I_{OL} = 4 mA
O		Input-only pin Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
P		LCDC output pin (COM pin)

■ HANDLING DEVICES

- **Strictly observe maximum rated voltages (preventing latch-up)**

In CMOS IC devices, a condition known as latch-up may occur if voltages higher than V_{CC} or lower than V_{SS} are applied to input or output pins other than medium or high withstand voltage pins, or if the voltage applied between VCC and VSS pins exceeds the rated voltage level. If a latch-up occurs, the power supply current may increase dramatically and may destroy semiconductor elements. When using semiconductor devices, always take sufficient care to avoid exceeding maximum ratings.

When the analog system power supply is switched on or off, be careful not to apply the analog power supply (AV_{CC}, AVRH), the analog input voltages and the power supply voltage for the high current output buffer pins (DV_{CC}) in excess of the digital power supply voltage (V_{CC}).

Once the digital power supply voltage (V_{CC}) has been disconnected, the analog power supply (AV_{CC}, AVRH) and the power supply voltage for the high current output buffer pins (DV_{CC}) may be turned on in any sequence.

- **Supply voltage stabilization**

Rapid fluctuations in the power supply voltage can cause malfunctions even if the Vcc power supply voltage remains within the warranted operating range. It is recommended that the power supply be stabilized such that ripple fluctuations (P-P value) at commercial frequencies (50 Hz/60 Hz) be limited to within 10% of the standard V_{CC} value, and that transient fluctuations due to power supply switching, etc. be limited to a rate of 0.1 V/ms or less.

- **Precautions when turning the power on**

In order to prevent the built-in step-down circuits from malfunctioning, the time taken for the voltage to rise (0.2 V to 2.7 V) during power-on should be less than 50 μs.

- **Handling unused pins**

If unused input pins are left open, they may cause malfunctions or latch-up which may lead to permanent damage to the semiconductor. Unused input pins should therefore be pulled up or pulled down through a resistor of at least 2 kΩ.

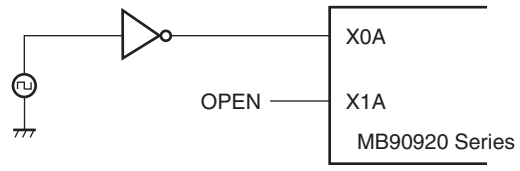
Unused input/output pins may be set to the output state and left open, or set to the input state and connected to a pull-up or pull-down resistance of 2 kΩ or more.

- **Handling A/D converter power supply pins**

Even if the A/D converter is not used, the power supply pins should be connected such as $AV_{CC} = V_{CC}$, and $AV_{SS} = AVRH = V_{SS}$.

- **Notes on using an external clock**

Even when an external clock is used, an oscillation stabilization wait time is required following power-on reset or release from sub clock mode or stop mode. Furthermore, only the X0A pin should be driven when an external clock is used, with the X1A pin open as shown in the following diagram. Do not use high-speed oscillation pins (X0 and X1) for external clock input.



Sample external clock connection

- **Notes on operating in PLL clock mode**

On this microcontroller, if in case the crystal oscillator breaks off or an external reference clock input stops while the PLL clock mode is selected, a self-oscillator circuit contained in the PLL may continue its operation at its self-running frequency. However, FUJITSU SEMICONDUCTOR will not guarantee results of operations if such failure occurs.

- **Crystal oscillator circuit**

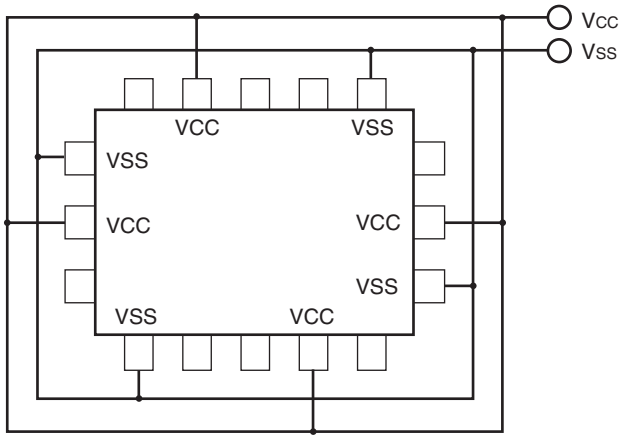
Noise around the X0/X1, or X0A/X1A pins may cause this device to operate abnormally. In the interest of stable operation it is strongly recommended that printed circuit artwork places ground bypass capacitors as close as possible to the X0/X1, X0A/X1A and crystal oscillator (or ceramic oscillator) and that oscillator lines do not cross the lines of other circuits.

Please ask each crystal maker to evaluate the oscillational characteristics of the crystal and this device.

- **Power supply pins**

Devices including multiple VCC or VSS pins are designed such that pins that need to be at the same potential are interconnected internally to prevent malfunctions such as latch-up. To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the VCC and VSS pins to the power supply and ground externally.

Always connect all of the VCC pins to the same potential and all of the VSS pins to ground as shown in the following diagram. The device will not operate correctly if multiple VCC or VSS pins are connected to different voltages, even if those voltages are within the guaranteed operating ranges.



Power supply input pins (Vcc/Vss)

In addition, care must be given to connecting the VCC and VSS pins of this device to the current supply source with as low impedance as possible. It is recommended that a 1.0 μF bypass capacitor be connected between the VCC and VSS pins as close to the pins as possible.

- **Sequence for connecting the A/D converter power supply and analog inputs**

The A/D converter power supply (AV_{CC}, AVRH) and analog inputs (AN0 to AN7) must be applied after the digital power supply (V_{CC}) is switched on. When turning the power off, the A/D converter power supply and analog inputs must be disconnected before the digital power supply is switched off (V_{CC}). Ensure that AVRH does not exceed AVcc during either power-on or power-off. Even when pins which double as analog input pins are used as input ports, be sure that the input voltage does not exceed AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

- **Handling the power supply for high-current output buffer pins** (DV_{CC}, DV_{SS})

  - **Flash memory products and MASK ROM products (MB90F922NC/F922NCS/922NCS/F923NC/ F923NCS/F924NC/F924NCS)**

    In the Flash memory products and MASK ROM products, the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is isolated from the digital power supply (V_{CC}).
    Therefore, DVcc can therefore be set to a higher voltage than Vcc. If the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is supplied before the digital power supply (V_{CC}), however, care needs to be taken because it is possible that the port 7 or port 8 stepping motor outputs may momentarily output an “H” or “L” level. In order to prevent this, connect the digital power supply (V_{CC}) prior to connecting the power supply for the high-current output buffer pins. Even when the high-current output buffer pins are used as general-purpose ports, power should be supplied to the power supply pins for the high-current output buffer pins (DV_{CC}, DV_{SS}).

  - **Evaluation product** (**MB90V920-101**/**MB90V920-102**)

    In the evaluation products, the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is not isolated from the digital power supply (V_{CC}). Therefore, DV_{CC} must therefore be set to a lower voltage than Vcc. The power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) must always be applied after the digital power supply (V_{CC}) has been connected, and disconnected before the digital power supply (Vcc) is disconnected (the power supply for the high-current output buffer pins may also be connected and disconnected simultaneously with the digital power supply).
    Even when the high-current output buffer pins are used as general-purpose ports, power should be supplied to the power supply pins for the high-current output buffer pins (DV_{CC}, DV_{SS}).

- **Pull-up/pull-down resistors**

MB90920 series does not support internal pull-up/pull-down resistors. Use external components as necessary.

- **Precautions when not using a sub clock signal**

If the X0A and X1A pins are not connected to an oscillator, apply a pull-down resistance to the X0A pin and leave the X1A pin open.

- **Notes on operating when the external clock is stopped**

The MB90920 series is not guaranteed to operate correctly using the internal oscillator circuit when there is no external oscillator or the external clock input is stopped.

- **Flash memory security function**

A security bit is located within the Flash memory region. The security function is activated by writing the protection code 01_H to the security bit.
Do not write the value 01_H to this address if you are not using the security function.
Please refer to following table for the address of the security bit.

	Flash memory size	Address for security bit
MB90F922NC MB90F922NCS	Built-in 2 Mbits Flash Memory	$FC0001_H$
MB90F923NCS	Built-in 3 Mbits Flash Memory	$F80001_H$
MB90F924NCS	Built-in 4 Mbits Flash Memory	$F80001_H$

- **Serial communication**

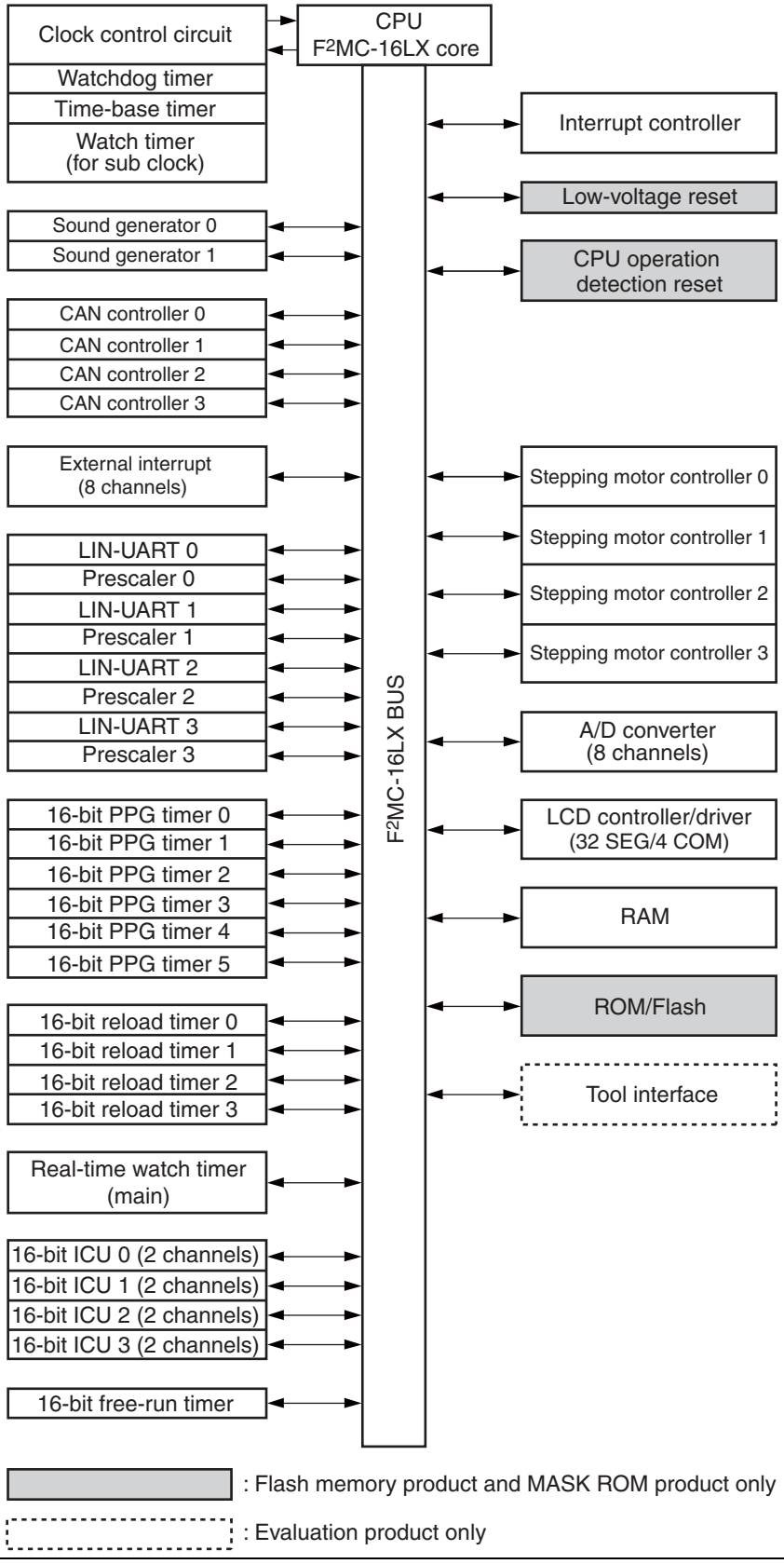
In serial communication, reception of wrong data may occur due to noise or other causes. Therefore, design a printed circuit board to prevent noise from occurring. Taking account of the reception of wrong data, detect errors by measures such as adding a checksum to the end of data. If an error is detected, retransmit the data.

- **Characteristic difference between flash device and MASK ROM device**

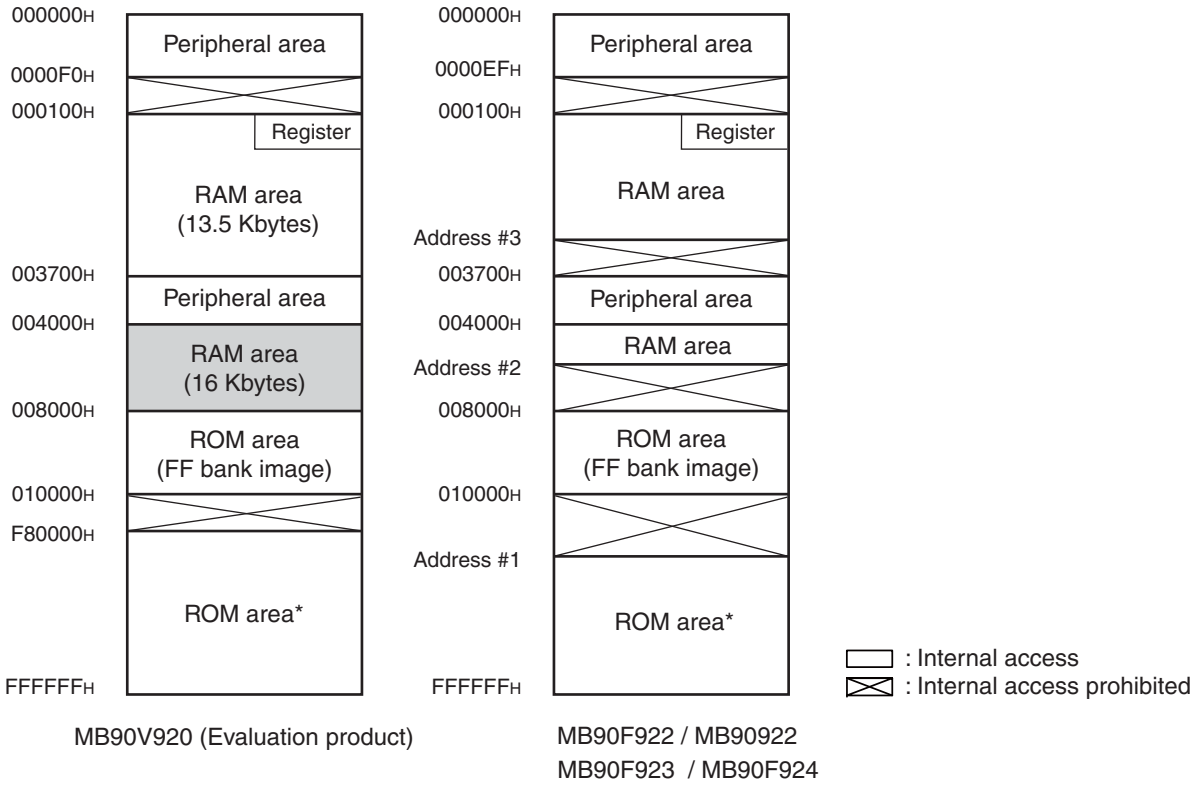
In the flash device and the MASK ROM device, the electrical characteristic including current consumption, ESD, latch-up, the noise characteristic, and oscillation characteristic, etc. is different according to the difference between the chip layout and the memory structure.

Reconfirm the electrical characteristic when the product is replaced by another product of the same series.

■ BLOCK DIAGRAM



■ MEMORY MAP



Parts No.	ROM (Flash) capacitance	RAM capacitance	Address #1	Address #2	Address #3
MB90F922NC/F922NCS/922NCS	256 Kbytes	10 Kbytes	FC0000H	004000H	002900H
MB90F923NC/F923NCS	384 Kbytes	16 Kbytes	FA0000H	004A00H	003700H
MB90F924NC/F924NCS	512 Kbytes	24 Kbytes	F80000H	006A00H	003700H

* : Evaluation products do not contain internal ROM. Treat this address as the ROM decode area used by the tools.

Note: To select models without the ROM mirror function, refer to the “ROM Mirror Function Selection Module” in Hardware Manual. The image of the ROM data in the FF bank appears at the top of the 00 bank, in order to enable efficient use of small C compiler models. The lower 16-bits of the FF bank addresses are allocated to the same addresses as the lower 16-bits of the 00 bank, making it possible to reference tables in ROM without declaring the “far” modifier with the pointers. For example, when an access is made to the address 00C000H, the actual address to be accessed is FFC000H in ROM. Because the size of the FF bank ROM area exceeds 32 Kbytes, it is not possible to view the entire region in the 00 bank image. Therefore because the ROM data from FF8000H to FFFFFFH appears in the image from 008000H to 00FFFFH, it is recommended that ROM data tables be stored in the area from FF8000H to FFFFFFH.

■ I/O MAP

Address	Register name	Symbol	Read/write	Resource name	Initial value
000000H	Port 0 data register	PDR0	R/W	Port 0	XXXXXXXXB
000001H	Port 1 data register	PDR1	R/W	Port 1	XXXXXXXXB
000002H	Port 2 data register	PDR2	R/W	Port 2	XXXXXXXXB
000003H	Port 3 data register	PDR3	R/W	Port 3	XXXXXXXXB
000004H	Port 4 data register	PDR4	R/W	Port 4	XXXXXXXXB
000005H	Port 5 data register	PDR5	R/W	Port 5	XXXXXXXXB
000006H	Port 6 data register	PDR6	R/W	Port 6	XXXXXXXXB
000007H	Port 7 data register	PDR7	R/W	Port 7	XXXXXXXXB
000008H	Port 8 data register	PDR8	R/W	Port 8	XXXXXXXXB
000009H	Port 9 data register	PDR9	R/W	Port 9	XXXXXXXXB
00000AH, 00000BH	(Disabled)				
00000CH	Port C data register	PDRC	R/W	Port C	XXXXXXXXB
00000DH	Port D data register	PDRD	R/W	Port D	XXXXXXXXB
00000EH	Port E data register	PDRE	R/W	Port E	XXXXXXXXB
00000FH	(Disabled)				
000010H	Port 0 direction register	DDR0	R/W	Port 0	00000000B
000011H	Port 1 direction register	DDR1	R/W	Port 1	XX000000B
000012H	Port 2 direction register	DDR2	R/W	Port 2	000000XXB
000013H	Port 3 direction register	DDR3	R/W	Port 3	00000000B
000014H	Port 4 direction register	DDR4	R/W	Port 4	00000000B
000015H	Port 5 direction register	DDR5	R/W	Port 5	00000000B
000016H	Port 6 direction register	DDR6	R/W	Port 6	00000000B
000017H	Port 7 direction register	DDR7	R/W	Port 7	00000000B
000018H	Port 8 direction register	DDR8	R/W	Port 8	00000000B
000019H	Port 9 direction register	DDR9	R/W	Port 9	X0000000B
00001AH	Analog input enable	ADER6	R/W	Port 6, A/D	11111111B
00001BH	(Disabled)				
00001CH	Port C direction register	DDRC	R/W	Port C	00000000B
00001DH	Port D direction register	DDRD	R/W	Port D	X0000000B
00001EH	Port E direction register	DDRE	R/W	Port E	XXXXX000B
00001FH	(Disabled)				
000020H	Lower A/D control status register	ADCS0	R/W	A/D converter	000XXXX0B
000021H	Higher A/D control status register	ADCS1	R/W		0000000XB
000022H	Lower A/D control status register	ADCR0	R		00000000B
000023H	Higher A/D data register	ADCR1	R		XXXXXX00B

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
000024H	Compare clear register	CPCLR	R/W	16-bit free-run timer	XXXXXXXXB
000025H			R/W		XXXXXXXXB
000026H	Timer data register	TCDT	R/W		00000000B
000027H			R/W		00000000B
000028H	Lower timer control status register	TCCSL	R/W		00000000B
000029H	Higher timer control status register	TCCSH	R/W		01-00000B
00002AH	Lower PPG0 control status register	PCNTL0	R/W	16-bit PPG0	00000000B
00002BH	Higher PPG0 control status register	PCNTH0	R/W		00000001B
00002CH	Lower PPG1 control status register	PCNTL1	R/W	16-bit PPG1	00000000B
00002DH	Higher PPG1 control status register	PCNTH1	R/W		00000001B
00002EH	Lower PPG2 control status register	PCNTL2	R/W	16-bit PPG2	00000000B
00002FH	Higher PPG2 control status register	PCNTH2	R/W		00000001B
000030H	External interrupt enable	ENIR	R/W	External interrupt	00000000B
000031H	External interrupt request	EIRR	R/W		00000000B
000032H	Lower external interrupt level	ELVRL	R/W		00000000B
000033H	Higher external interrupt level	ELVRH	R/W		00000000B
000034H	Serial mode register 0	SMR0	R/W, W	UART (LIN/SCI) 0	00000000B
000035H	Serial control register 0	SCR0	R/W, W		00000000B
000036H	Reception/transmission data register 1	RDR0/ TDR0	R/W		00000000B
000037H	Serial status register 0	SSR0	R/W, R		00001000B
000038H	Extended communication control register 0	ECCR0	R/W, R		000000XXB
000039H	Extended status control register 0	ESCR0	R/W		00000100B
00003AH	Baud rate generator register 00	BGR00	R/W		00000000B
00003BH	Baud rate generator register 01	BGR01	R/W, R		00000000B
00003CH to 00003FH	(Disabled)				
000040H to 00004FH	Area reserved for CAN Controller 0. Refer to "■ CAN CONTROLLERS"				
000050H	Lower timer control status register 0	TMCSR0L	R/W	16-bit reload timer 0	00000000B
000051H	Higher timer control status register 0	TMCSR0H	R/W		XXX10000B
000052H	Timer register 0/reload register 0	TMR0/ TMRLR0	R/W		XXXXXXXXB
000053H					XXXXXXXXB

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
000054H	Lower timer control status register 1	TMCSR1L	R/W	16-bit reload timer 1	00000000B
000055H	Higher timer control status register 1	TMCSR1H	R/W		XXX10000B
000056H	Timer register 1/reload register 1	TMR1/ TMRLR1	R/W		XXXXXXXXB
000057H					XXXXXXXXB
000058H	LCD output control register 1	LOCR1	R/W	LCDC	11111111B
000059H	LCD output control register 2	LOCR2	R/W		00000000B
00005AH	Lower sound control register 0	SGCRL0	R/W	Sound generator 0	00000000B
00005BH	Higher sound control register 0	SGCRH0	R/W		0XXXX100B
00005CH	Frequency data register 0	SGFR0	R/W		XXXXXXXXB
00005DH	Amplitude data register 0	SGAR0	R/W		00000000B
00005EH	Decrement grade register 0	SGDR0	R/W		XXXXXXXXB
00005FH	Tone count register 0	SGTR0	R/W		XXXXXXXXB
000060H	Input capture register 0	IPCP0	R	Input capture 0/1	XXXXXXXXB
000061H					XXXXXXXXB
000062H	Input capture register 1	IPCP1	R		XXXXXXXXB
000063H					XXXXXXXXB
000064H	Input capture register 2	IPCP2	R	Input capture 2/3	XXXXXXXXB
000065H					XXXXXXXXB
000066H	Input capture register 3	IPCP3	R		XXXXXXXXB
000067H					XXXXXXXXB
000068H	Input capture control status 0/1	ICS01	R/W	Input capture 0/1	00000000B
000069H	Input capture edge register 0/1	ICE01	R/W		XXX0X0XXB
00006AH	Input capture control status 2/3	ICS23	R/W	Input capture 2/3	00000000B
00006BH	Input capture edge register 2/3	ICE23	R/W		XXXXXXXXB
00006CH	Lower LCD control register	LCRL	R/W	LCD controller/ driver	00010000B
00006DH	Higher LCD control register	LCRH	R/W		00000000B
00006EH	Low voltage/CPU operation detection reset control register	LVRC	R/W	Low voltage/CPU operation detection reset	00111000B
00006FH	ROM mirror	ROMM	W	ROM mirror	XXXXXXX1B
000070H to 00007FH	Area reserved for CAN Controller 1. Refer to "■ CAN CONTROLLERS"				
000080H	PWM control register 0	PWC0	R/W	Stepping motor controller 0	000000X0B
000081H	(Disabled)				
000082H	PWM control register 1	PWC1	R/W	Stepping motor controller 1	000000X0B

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
000083H	(Disabled)				
000084H	PWM control register 2	PWC2	R/W	Stepping motor controller 2	000000X0B
000085H	(Disabled)				
000086H	PWM control register 3	PWC3	R/W	Stepping motor controller 3	000000X0B
000087H	(Disabled)				
000088H	LCD output control register 3	LOCR3	R/W	LCDC	XXXXX111B
000089H	(Disabled)				
00008AH	A/D setting register 0	ADSR0	R/W	A/D converter	00000000B
00008BH	A/D setting register 1	ADSR1	R/W		00000000B
00008CH	Port input level select 0	PIL0	R/W	Port input level select	00000000B
00008DH	Port input level select 1	PIL1	R/W		XXXX0000B
00008EH	Port input level select 2	PIL2	R/W		XXXX0000B
00008FH to 00009DH	(Disabled)				
00009EH	Program address detection control register	PACSR	R/W	Address match detection	XXXX0X0XB
00009FH	Delayed Interrupt/Release Register	DIRR	R/W	Delay interrupt	XXXXXXX0B
0000A0H	Power saving mode control register	LPMCR	R/W	Power saving control circuit	00011000B
0000A1H	Clock select register	CKSCR	R/W, R		11111100B
0000A2H to 0000A7H	(Disabled)				
0000A8H	Watchdog timer control register	WDTC	R, W	Watchdog timer	XXXXX111B
0000A9H	Time-base timer control register	TBTC	R/W, W	Time-base timer	1XX00100B
0000AAH	Watch timer control register	WTC	R/W, W, R	Watch timer (sub clock)	10001000B
0000ABH to 0000ADH	(Disabled)				
0000AEH	Flash memory control status register	FMCS	R/W	Flash interface	000X0000B
0000AFH	(Disabled)				

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
0000B0H	Interrupt control register 00	ICR00	R/W	Interrupt controller	00000111B
0000B1H	Interrupt control register 01	ICR01	R/W		00000111B
0000B2H	Interrupt control register 02	ICR02	R/W		00000111B
0000B3H	Interrupt control register 03	ICR03	R/W		00000111B
0000B4H	Interrupt control register 04	ICR04	R/W		00000111B
0000B5H	Interrupt control register 05	ICR05	R/W		00000111B
0000B6H	Interrupt control register 06	ICR06	R/W		00000111B
0000B7H	Interrupt control register 07	ICR07	R/W		00000111B
0000B8H	Interrupt control register 08	ICR08	R/W		00000111B
0000B9H	Interrupt control register 09	ICR09	R/W		00000111B
0000BAH	Interrupt control register 10	ICR10	R/W		00000111B
0000BBH	Interrupt control register 11	ICR11	R/W		00000111B
0000BCH	Interrupt control register 12	ICR12	R/W		00000111B
0000BDH	Interrupt control register 13	ICR13	R/W		00000111B
0000BEH	Interrupt control register 14	ICR14	R/W		00000111B
0000BFH	Interrupt control register 15	ICR15	R/W		00000111B
0000C0H to 0000C3H	(Disabled)				
0000C4H	Serial mode register 1	SMR1	R/W, W	UART (LIN/SCI) 1	00000000B
0000C5H	Serial control register 1	SCR1	R/W, W		00000000B
0000C6H	Reception/transmission data register 1	RDR1/ TDR1	R/W		00000000B
0000C7H	Serial status register 1	SSR1	R/W, R		00001000B
0000C8H	Extended communication control register 1	ECCR1	R/W, R		000000XXB
0000C9H	Extended status control register 1	ESCR1	R/W		00000100B
0000CAH	Baud rate generator register 10	BGR10	R/W		00000000B
0000CBH	Baud rate generator register 11	BGR11	R/W, R		00000000B
0000CCH	Lower watch timer control register	WTCRL	R/W	Real-time watch timer	000XXXX0B
0000CDH	Middle watch timer control register	WTCRM	R/W		00000000B
0000CEH	Higher watch timer control register	WTCRH	R/W		XXXXXX00B
0000CFH	Sub clock control register	PSCCR	W	Sub clock	XXXX0000B
0000D0H	Input capture control status 4/5	ICS45	R/W	Input capture 4/5	00000000B
0000D1H	Input capture edge register 4/5	ICE45	R/W, R		XXXXXXXXB
0000D2H	Input capture control status 6/7	ICS67	R/W	Input capture 6/7	00000000B
0000D3H	Input capture edge register 6/7	ICE67	R/W, R		XXX0X0XXB

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
0000D4H	Lower timer control status register 2	TMCSR2L	R/W	16-bit reload timer 2	00000000B
0000D5H	Higher timer control status register 2	TMCSR2H	R/W		XXX10000B
0000D6H	Lower timer control status register 3	TMCSR3L	R/W	16-bit reload timer 3	00000000B
0000D7H	Higher timer control status register 3	TMCSR3H	R/W		XXX10000B
0000D8H	Lower sound control register 1	SGCRL1	R/W	Sound generator 1	00000000B
0000D9H	Higher sound control register 1	SGCRH1	R/W		0XXXX100B
0000DAH	Lower PPG3 control status register	PCNTL3	R/W	16-bit PPG3	00000000B
0000DBH	Higher PPG3 control status register	PCNTH3	R/W		00000001B
0000DCH	Lower PPG4 control status register	PCNTL4	R/W	16-bit PPG4	00000000B
0000DDH	Higher PPG4 control status register	PCNTH4	R/W		00000001B
0000DEH	Lower PPG5 control status register	PCNTL5	R/W	16-bit PPG5	00000000B
0000DFH	Higher PPG5 control status register	PCNTH5	R/W		00000001B
0000E0H	Serial mode register 2	SMR2	R/W, W	UART (LIN/SCI) 2	00000000B
0000E1H	Serial control register 2	SCR2	R/W, W		00000000B
0000E2H	Reception/transmission data register 2	RDR2/ TDR2	R/W		00000000B
0000E3H	Serial status register 2	SSR2	R/W, R		00001000B
0000E4H	Extended communication control register 2	ECCR2	R/W, R		000000XXB
0000E5H	Extended status control register 2	ESCR2	R/W		00000100B
0000E6H	Baud rate generator register 20	BGR20	R/W		00000000B
0000E7H	Baud rate generator register 21	BGR21	R/W, R		00000000B
0000E8H	Serial mode register 3	SMR3	R/W, W	UART (LIN/SCI) 3	00000000B
0000E9H	Serial control register 3	SCR3	R/W, W		00000000B
0000EAH	Reception/transmission data register 3	RDR3/ TDR3	R/W		00000000B
0000EBH	Serial status register 3	SSR3	R/W, R		00001000B
0000ECH	Extended communication control register 3	ECCR3	R/W, R		000000XXB
0000EDH	Extended status control register 3	ESCR3	R/W		00000100B
0000EEH	Baud rate generator register 30	BGR30	R/W		00000000B
0000EFH	Baud rate generator register 31	BGR31	R/W, R		00000000B
001FF0H	Program address detection register 0	PADR0	R/W	Address match detection	XXXXXXXXB
001FF1H	Program address detection register 1	PADR0	R/W		XXXXXXXXB
001FF2H	Program address detection register 2	PADR0	R/W		XXXXXXXXB
001FF3H	Program address detection register 3	PADR1	R/W		XXXXXXXXB
001FF4H	Program address detection register 4	PADR1	R/W		XXXXXXXXB
001FF5H	Program address detection register 5	PADR1	R/W		XXXXXXXXB

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
003700H to 0037FFH	Area reserved for CAN Controller 2. Refer to "■ CAN CONTROLLERS"				
003800H to 0038FFH	Area reserved for CAN Controller 3. Refer to "■ CAN CONTROLLERS"				
003900H to 00391FH	(Disabled)				
003920H	PPG0 down counter register	PDCR0	R	16-bit PPG0	11111111B
003921H					11111111B
003922H	PPG0 cycle setting register	PCSR0	W		11111111B
003923H					11111111B
003924H	PPG0 duty setting register	PDUT0	W	16-bit PPG0	00000000B
003925H					00000000B
003926H	PPG0 output division setting register	PPGDIV0	R/W, R		11111100B
003927H	(Disabled)				
003928H	PPG1 down counter register	PDCR1	R	16-bit PPG1	11111111B
003929H					11111111B
00392AH	PPG1 cycle setting register	PCSR1	W		11111111B
00392BH					11111111B
00392CH	PPG1 duty setting register	PDUT1	W		00000000B
00392DH					00000000B
00392EH	PPG1output division setting register	PPGDIV1	R/W, R		11111100B
00392FH	(Disabled)				
003930H	PPG2 down counter register	PDCR2	R	16-bit PPG2	11111111B
003931H					11111111B
003932H	PPG2 cycle setting register	PCSR2	W		11111111B
003933H					11111111B
003934H	PPG2 duty setting register	PDUT2	W		00000000B
003935H					00000000B
003936H	PPG2 output division setting register	PPGDIV2	R/W, R		11111100B
003937H to 00393FH	(Disabled)				
003940H	Input capture register 4	IPCP4	R	Input capture 4/5	XXXXXXXXB
003941H					XXXXXXXXB
003942H	Input capture register 5	IPCP5	R		XXXXXXXXB
003943H					XXXXXXXXB

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
003944H	Input capture register 6	IPCP6	R	Input capture 6/7	XXXXXXXXB
003945H					XXXXXXXXB
003946H	Input capture register 7	IPCP7	R		XXXXXXXXB
003947H					XXXXXXXXB
003948H to 00394FH	(Disabled)				
003950H	Minute data register 2/Reload register 2	TMR2/ TMRLR2	R/W	16-bit reload timer 2	XXXXXXXXB
003951H					XXXXXXXXB
003952H	Minute data register 3/Reload register 3	TMR3/ TMRLR3	R/W	16-bit reload timer 3	XXXXXXXXB
003953H					XXXXXXXXB
003954H to 003957H	(Disabled)				
003958H	Sub second data register	WTBR	R/W	Real time watch timer	XXXXXXXXB
003959H					XXXXXXXXB
00395AH					XXXXXXXXB
00395BH	Second data register	WTSR	R/W		XX000000B
00395CH	Minute data register	WTMR	R/W		XX000000B
00395DH	Hour data register	WTHR	R/W		XXX00000B
00395EH	Day data register	WTDR	R/W		00X00001B
00395FH	(Disabled)				
003960H	LCD display RAM	VRAM	R/W	LCD controller/ driver	XXXXXXXXB
003961H					XXXXXXXXB
003962H					XXXXXXXXB
003963H					XXXXXXXXB
003964H					XXXXXXXXB
003965H					XXXXXXXXB
003966H					XXXXXXXXB
003967H					XXXXXXXXB
003968H					XXXXXXXXB
003969H					XXXXXXXXB
00396AH					XXXXXXXXB
00396BH					XXXXXXXXB
00396CH					XXXXXXXXB
00396DH					XXXXXXXXB
00396EH					XXXXXXXXB
00396FH					XXXXXXXXB

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
003970H to 003973H	(Disabled)				
003974H	Frequency data register 1	SGFR1	R/W	Sound generator 1	XXXXXXXXB
003975H	Amplitude data register 1	SGAR1	R/W		00000000B
003976H	Decrement grade register 1	SGDR1	R/W		XXXXXXXXB
003977H	Tone count register 1	SGTR1	R/W		XXXXXXXXB
003978H to 00397FH	(Disabled)				
003980H	PWM1 compare register 0	PWC10	R/W	Stepping motor controller 0	XXXXXXXXB
003981H					XXXXXXXXB
003982H	PWM2 compare register 0	PWC20	R/W		XXXXXXXXB
003983H					XXXXXXXXB
003984H	PWM1 select register 0	PWS10	R/W		00000000B
003985H	PWM2 select register 0	PWS20	R/W		X0000000B
003986H, 003987H	(Disabled)				
003988H	PWM1 compare register 1	PWC11	R/W	Stepping motor controller 1	XXXXXXXXB
003989H					XXXXXXXXB
00398AH	PWM2 compare register 1	PWC21	R/W		XXXXXXXXB
00398BH					XXXXXXXXB
00398CH	PWM1 select register 1	PWS11	R/W		00000000B
00398DH	PWM2 select register 1	PWS21	R/W		X0000000B
00398EH, 00398FH	(Disabled)				
003990H	PWM1 compare register 2	PWC12	R/W	Stepping motor controller 2	XXXXXXXXB
003991H					XXXXXXXXB
003992H	PWM2 compare register 2	PWC22	R/W		XXXXXXXXB
003993H					XXXXXXXXB
003994H	PWM1 select register 2	PWS12	R/W		00000000B
003995H	PWM2 select register 2	PWS22	R/W		X0000000B
003996H, 003997H	(Disabled)				

(Continued)

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Address	Register name	Symbol	Read/write	Resource name	Initial value
003998H	PWM1 compare register 3	PWC13	R/W	Stepping motor controller 3	XXXXXXXXB
003999H					XXXXXXXXB
00399AH	PWM2 compare register 3	PWC23	R/W		XXXXXXXXB
00399BH					XXXXXXXXB
00399CH	PWM1 select register 3	PWS13	R/W		00000000B
00399DH	PWM2 select register 3	PWS23	R/W		X0000000B
00399EH to 0039A5H	(Disabled)				
0039A6H	Flash write control register 0	FWR0	R/W	Flash I/F	00000000B
0039A7H	Flash write control register 1	FWR1			00000000B
0039A8H to 0039BFH	(Disabled)				
0039C0H to 0039DFH	Area reserved for CAN Controller 2. Refer to “■ CAN CONTROLLERS”				
0039E0H to 0039FFH	Area reserved for CAN Controller 3. Refer to “■ CAN CONTROLLERS”				
003A00H to 003AFFH	Area reserved for CAN Controller 0. Refer to “■ CAN CONTROLLERS”				
003B00H to 003BFFH	Area reserved for CAN Controller 1. Refer to “■ CAN CONTROLLERS”				
003C00H to 003CFFH	Area reserved for CAN Controller 0. Refer to “■ CAN CONTROLLERS”				
003D00H to 003DFFH	Area reserved for CAN Controller 1. Refer to “■ CAN CONTROLLERS”				
003E00H to 003EFFH	Area reserved for CAN Controller 2. Refer to “■ CAN CONTROLLERS”				
003F00H to 003FFFH	Area reserved for CAN Controller 3. Refer to “■ CAN CONTROLLERS”				

■ CAN CONTROLLERS

The CAN controller has the following features :

- Conforms to CAN Specification Version 2.0 Part A and B
  - Supports transmission/reception in standard frame and extended frame formats
- Supports transmission of data frames by receiving remote frames
- 16 transmission/reception message buffers
  - 29-bit ID and 8-byte data
  - Multi-level message buffer configuration
- Provides full-bit comparison, full-bit mask, acceptance register 0/acceptance register 1 for each message buffer as ID acceptance mask
  - 2 acceptance mask registers in either standard frame format or extended frame formats
- Bit rate programmable from 10 kbps to 2 Mbps (when input clock is at 16 MHz)

List of Control Registers(1)

Address				Register	Abbreviation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003C00H	003D00H	003E00H	003F00H	Control status register	CSR	R/W, R	00---000B 0----0-1B
003C01H	003D01H	003E01H	003F01H				
003C02H	003D02H	003E02H	003F02H	Last event indicator register	LEIR	R/W	--------B 000-0000B
003C03H	003D03H	003E03H	003F03H				
003C04H	003D04H	003E04H	003F04H	RX/TX error counter	RTEC	R	00000000B 00000000B
003C05H	003D05H	003E05H	003F05H				
003C06H	003D06H	003E06H	003F06H	Bit timing register	BTR	R/W	-1111111B 11111111B
003C07H	003D07H	003E07H	003F07H				

List of Control Registers(2)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
000040H	000070H	0039C0H	0039D0H	Message buffer valid register	BVALR	R/W	00000000B
000041H	000071H	0039C1H	0039D1H				00000000B
000042H	000072H	0039C2H	0039D2H	Transmit request register	TREQR	R/W	00000000B
000043H	000073H	0039C3H	0039D3H				00000000B
000044H	000074H	0039C4H	0039D4H	Transmit cancel register	TCANR	W	00000000B
000045H	000075H	0039C5H	0039D5H				00000000B
000046H	000076H	0039C6H	0039D6H	Transmit complete register	TCR	R/W	00000000B
000047H	000077H	0039C7H	0039D7H				00000000B
000048H	000078H	0039C8H	0039D8H	Receive complete register	RCR	R/W	00000000B
000049H	000079H	0039C9H	0039D9H				00000000B
00004AH	00007AH	0039CAH	0039DAH	Remote request receive register	RRTRR	R/W	00000000B
00004BH	00007BH	0039CBH	0039DBH				00000000B
00004CH	00007CH	0039CCH	0039DCH	Receive overrun register	ROVRR	R/W	00000000B
00004DH	00007DH	0039CDH	0039DDH				00000000B
00004EH	00007EH	0039CEH	0039DEH	Receive interrupt enable register	RIER	R/W	00000000B
00004FH	00007FH	0039CFH	0039DFH				00000000B
003C08H	003D08H	003E08H	003F08H	IDE register	IDER	R/W	XXXXXXXXB
003C09H	003D09H	003E09H	003F09H				XXXXXXXXB
003C0AH	003D0AH	003E0AH	003F0AH	Transmit RTR register	TRTRR	R/W	00000000B
003C0BH	003D0BH	003E0BH	003F0BH				00000000B
003C0CH	003D0CH	003E0CH	003F0CH	Remote frame receive wait register	RFWTR	R/W	XXXXXXXXB
003C0DH	003D0DH	003E0DH	003F0DH				XXXXXXXXB
003C0EH	003D0EH	003E0EH	003F0EH	Transmit interrupt enable register	TIER	R/W	00000000B
003C0FH	003D0FH	003E0FH	003F0FH				00000000B
003C10H	003D10H	003E10H	003F10H	Acceptance mask select register	AMSR	R/W	XXXXXXXXB
003C11H	003D11H	003E11H	003F11H				XXXXXXXXB
003C12H	003D12H	003E12H	003F12H				XXXXXXXXB
003C13H	003D13H	003E13H	003F13H				XXXXXXXXB
003C14H	003D14H	003E14H	003F14H	Acceptance mask register 0	AMR0	R/W	XXXXXXXXB
003C15H	003D15H	003E15H	003F15H				XXXXXXXXB
003C16H	003D16H	003E16H	003F16H				XXXXX---B
003C17H	003D17H	003E17H	003F17H				XXXXXXXXB
003C18H	003D18H	003E18H	003F18H	Acceptance mask register 1	AMR1	R/W	XXXXXXXXB
003C19H	003D19H	003E19H	003F19H				XXXXXXXXB
003C1AH	003D1AH	003E1AH	003F1AH				XXXXX---B
003C1BH	003D1BH	003E1BH	003F1BH				XXXXXXXXB

List of Message Buffers (ID Registers)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A00H to 003A1FH	003B00H to 003B1FH	003700H to 00371FH	003800H to 00381FH	General-purpose RAM	—	R/W	XXXXXXXXB to XXXXXXXXB
003A20H	003B20H	003720H	003820H	ID register 0	IDR0	R/W	XXXXXXXXB XXXXXXXXB
003A21H	003B21H	003721H	003821H				
003A22H	003B22H	003722H	003822H				XXXXX---B XXXXXXXXB
003A23H	003B23H	003723H	003823H				
003A24H	003B24H	003724H	003824H	ID register 1	IDR1	R/W	XXXXXXXXB XXXXXXXXB
003A25H	003B25H	003725H	003825H				
003A26H	003B26H	003726H	003826H				XXXXX---B XXXXXXXXB
003A27H	003B27H	003727H	003827H				
003A28H	003B28H	003728H	003828H	ID register 2	IDR2	R/W	XXXXXXXXB XXXXXXXXB
003A29H	003B29H	003729H	003829H				
003A2AH	003B2AH	00372AH	00382AH				XXXXX---B XXXXXXXXB
003A2BH	003B2BH	00372BH	00382BH				
003A2CH	003B2CH	00372CH	00382CH	ID register 3	IDR3	R/W	XXXXXXXXB XXXXXXXXB
003A2DH	003B2DH	00372DH	00382DH				
003A2EH	003B2EH	00372EH	00382EH				XXXXX---B XXXXXXXXB
003A2FH	003B2FH	00372FH	00382FH				
003A30H	003B30H	003730H	003830H	ID register 4	IDR4	R/W	XXXXXXXXB XXXXXXXXB
003A31H	003B31H	003731H	003831H				
003A32H	003B32H	003732H	003832H				XXXXX---B XXXXXXXXB
003A33H	003B33H	003733H	003833H				
003A34H	003B34H	003734H	003834H	ID register 5	IDR5	R/W	XXXXXXXXB XXXXXXXXB
003A35H	003B35H	003735H	003835H				
003A36H	003B36H	003736H	003836H				XXXXX---B XXXXXXXXB
003A37H	003B37H	003737H	003837H				
003A38H	003B38H	003738H	003838H	ID register 6	IDR6	R/W	XXXXXXXXB XXXXXXXXB
003A39H	003B39H	003739H	003839H				
003A3AH	003B3AH	00373AH	00383AH				XXXXX---B XXXXXXXXB
003A3BH	003B3BH	00373BH	00383BH				
003A3CH	003B3CH	00373CH	00383CH	ID register 7	IDR7	R/W	XXXXXXXXB XXXXXXXXB
003A3DH	003B3DH	00373DH	00383DH				
003A3EH	003B3EH	00373EH	00383EH				XXXXX---B XXXXXXXXB
003A3FH	003B3FH	00373FH	00383FH				

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Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A40H	003B40H	003740H	003840H	ID register 8	IDR8	R/W	XXXXXXXXB XXXXXXXXB
003A41H	003B41H	003741H	003841H				
003A42H	003B42H	003742H	003842H				XXXXX---B XXXXXXXXB
003A43H	003B43H	003743H	003843H				
003A44H	003B44H	003744H	003844H	ID register 9	IDR9	R/W	XXXXXXXXB XXXXXXXXB
003A45H	003B45H	003745H	003845H				
003A46H	003B46H	003746H	003846H				XXXXX---B XXXXXXXXB
003A47H	003B47H	003747H	003847H				
003A48H	003B48H	003748H	003848H	ID register 10	IDR10	R/W	XXXXXXXXB XXXXXXXXB
003A49H	003B49H	003749H	003849H				
003A4AH	003B4AH	00374AH	00384AH				XXXXX---B XXXXXXXXB
003A4BH	003B4BH	00374BH	00384BH				
003A4CH	003B4CH	00374CH	00384CH	ID register 11	IDR11	R/W	XXXXXXXXB XXXXXXXXB
003A4DH	003B4DH	00374DH	00384DH				
003A4EH	003B4EH	00374EH	00384EH				XXXXX---B XXXXXXXXB
003A4FH	003B4FH	00374FH	00384FH				
003A50H	003B50H	003750H	003850H	ID register 12	IDR12	R/W	XXXXXXXXB XXXXXXXXB
003A51H	003B51H	003751H	003851H				
003A52H	003B52H	003752H	003852H				XXXXX---B XXXXXXXXB
003A53H	003B53H	003753H	003853H				
003A54H	003B54H	003754H	003854H	ID register 13	IDR13	R/W	XXXXXXXXB XXXXXXXXB
003A55H	003B55H	003755H	003855H				
003A56H	003B56H	003756H	003856H				XXXXX---B XXXXXXXXB
003A57H	003B57H	003757H	003857H				
003A58H	003B58H	003758H	003858H	ID register 14	IDR14	R/W	XXXXXXXXB XXXXXXXXB
003A59H	003B59H	003759H	003859H				
003A5AH	003B5AH	00375AH	00385AH				XXXXX---B XXXXXXXXB
003A5BH	003B5BH	00375BH	00385BH				
003A5CH	003B5CH	00375CH	00385CH	ID register 15	IDR15	R/W	XXXXXXXXB XXXXXXXXB
003A5DH	003B5DH	00375DH	00385DH				
003A5EH	003B5EH	00375EH	00385EH				XXXXX---B XXXXXXXXB
003A5FH	003B5FH	00375FH	00385FH				

List of Message Buffers (DLC Registers)

Address				Register	Abbreviation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A60H	003B60H	003760H	003860H	DLC register 0	DLCR0	R/W	----XXXXB
003A61H	003B61H	003761H	003861H				
003A62H	003B62H	003762H	003862H	DLC register 1	DLCR1	R/W	----XXXXB
003A63H	003B63H	003763H	003863H				
003A64H	003B64H	003764H	003864H	DLC register 2	DLCR2	R/W	----XXXXB
003A65H	003B65H	003765H	003865H				
003A66H	003B66H	003766H	003866H	DLC register 3	DLCR3	R/W	----XXXXB
003A67H	003B67H	003767H	003867H				
003A68H	003B68H	003768H	003868H	DLC register 4	DLCR4	R/W	----XXXXB
003A69H	003B69H	003769H	003869H				
003A6AH	003B6AH	00376AH	00386AH	DLC register 5	DLCR5	R/W	----XXXXB
003A6BH	003B6BH	00376BH	00386BH				
003A6CH	003B6CH	00376CH	00386CH	DLC register 6	DLCR6	R/W	----XXXXB
003A6DH	003B6DH	00376DH	00386DH				
003A6EH	003B6EH	00376EH	00386EH	DLC register 7	DLCR7	R/W	----XXXXB
003A6FH	003B6FH	00376FH	00386FH				
003A70H	003B70H	003770H	003870H	DLC register 8	DLCR8	R/W	----XXXXB
003A71H	003B71H	003771H	003871H				
003A72H	003B72H	003772H	003872H	DLC register 9	DLCR9	R/W	----XXXXB
003A73H	003B73H	003773H	003873H				
003A74H	003B74H	003774H	003874H	DLC register 10	DLCR10	R/W	----XXXXB
003A75H	003B75H	003775H	003875H				
003A76H	003B76H	003776H	003876H	DLC register 11	DLCR11	R/W	----XXXXB
003A77H	003B77H	003777H	003877H				
003A78H	003B78H	003778H	003878H	DLC register 12	DLCR12	R/W	----XXXXB
003A79H	003B79H	003779H	003879H				
003A7AH	003B7AH	00377AH	00387AH	DLC register 13	DLCR13	R/W	----XXXXB
003A7BH	003B7BH	00377BH	00387BH				
003A7CH	003B7CH	00377CH	00387CH	DLC register 14	DLCR14	R/W	----XXXXB
003A7DH	003B7DH	00377DH	00387DH				
003A7EH	003B7EH	00377EH	00387EH	DLC register 15	DLCR15	R/W	----XXXXB
003A7FH	003B7FH	00377FH	00387FH				

List of Message Buffers (Data register)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A80H to 003A87H	003B80H to 003B87H	003780H to 003787H	003880H to 003887H	Data register 0 (8 bytes)	DTR0	R/W	XXXXXXXXB to XXXXXXXXB
003A88H to 003A8FH	003B88H to 003B8FH	003788H to 00378FH	003888H to 00388FH	Data register 1 (8 bytes)	DTR1	R/W	XXXXXXXXB to XXXXXXXXB
003A90H to 003A97H	003B90H to 003B97H	003790H to 003797H	003890H to 003897H	Data register 2 (8 bytes)	DTR2	R/W	XXXXXXXXB to XXXXXXXXB
003A98H to 003A9FH	003B98H to 003B9FH	003798H to 00379FH	003898H to 00389FH	Data register 3 (8 bytes)	DTR3	R/W	XXXXXXXXB to XXXXXXXXB
003AA0H to 003AA7H	003BA0H to 003BA7H	0037A0H to 0037A7H	0038A0H to 0038A7H	Data register 4 (8 bytes)	DTR4	R/W	XXXXXXXXB to XXXXXXXXB
003AA8H to 003AAFH	003BA8H to 003BAFH	0037A8H to 0037AFH	0038A8H to 0038AFH	Data register 5 (8 bytes)	DTR5	R/W	XXXXXXXXB to XXXXXXXXB
003AB0H to 003AB7H	003BB0H to 003BB7H	0037B0H to 0037B7H	0038B0H to 0038B7H	Data register 6 (8 bytes)	DTR6	R/W	XXXXXXXXB to XXXXXXXXB
003AB8H to 003ABFH	003BB8H to 003BBFH	0037B8H to 0037BFH	0038B8H to 0038BFH	Data register 7 (8 bytes)	DTR7	R/W	XXXXXXXXB to XXXXXXXXB
003AC0H to 003AC7H	003BC0H to 003BC7H	0037C0H to 0037C7H	0038C0H to 0038C7H	Data register 8 (8 bytes)	DTR8	R/W	XXXXXXXXB to XXXXXXXXB
003AC8H to 003ACFH	003BC8H to 003BCFH	0037C8H to 0037CFH	0038C8H to 0038CFH	Data register 9 (8 bytes)	DTR9	R/W	XXXXXXXXB to XXXXXXXXB
003AD0H to 003AD7H	003BD0H to 003BD7H	0037D0H to 0037D7H	0038D0H to 0038D7H	Data register 10 (8 bytes)	DTR10	R/W	XXXXXXXXB to XXXXXXXXB
003AD8H to 003ADFH	003BD8H to 003BDFH	0037D8H to 0037DFH	0038D8H to 0038DFH	Data register 11 (8 bytes)	DTR11	R/W	XXXXXXXXB to XXXXXXXXB
003AE0H to 003AE7H	003BE0H to 003BE7H	0037E0H to 0037E7H	0038E0H to 0038E7H	Data register 12 (8 bytes)	DTR12	R/W	XXXXXXXXB to XXXXXXXXB
003AE8H to 003AEFH	003BE8H to 003BEFH	0037E8H to 0037EFH	0038E8H to 0038EFH	Data register 13 (8 bytes)	DTR13	R/W	XXXXXXXXB to XXXXXXXXB
003AF0H to 003AF7H	003BF0H to 003BF7H	0037F0H to 0037F7H	0038F0H to 0038F7H	Data register 14 (8 bytes)	DTR14	R/W	XXXXXXXXB to XXXXXXXXB
003AF8H to 003AFFH	003BF8H to 003BFFH	0037F8H to 0037FFH	0038F8H to 0038FFH	Data register 15 (8 bytes)	DTR15	R/W	XXXXXXXXB to XXXXXXXXB

■ INTERRUPT SOURCES, INTERRUPT VECTORS, AND INTERRUPT CONTROL REGISTERS

Interrupt source	EI²OS corresponding	Interrupt vector			Interrupt control register		Priority *2
		Number		Address	ICR	Address	
Reset	×	#08	08H	FFFFDCH	—	—	High
INT9 instruction	×	#09	09H	FFFFD8H	—	—	
Exception processing	×	#10	0AH	FFFFD4H	—	—	
CAN0 received/CAN2 received	×	#11	0BH	FFFFD0H	ICR00	0000B0H*1	
CAN0 transmitted/node status/ CAN2 transmitted/node status	×	#12	0CH	FFFFCCH			
CAN1 received/CAN3 received	×	#13	0DH	FFFFC8H	ICR01	0000B1H*1	
CAN1 transmitted/node status/ CAN3 transmitted/node status/SIO	×	#14	0EH	FFFFC4H			
Input capture 0	△	#15	0FH	FFFFC0H	ICR02	0000B2H*1	
DTP/ external interrupt - ch.0/ch.1 detected	△	#16	10H	FFFFBCH			
Reload timer 0	△	#17	11H	FFFFB8H	ICR03	0000B3H*1	
Reload timer 2	△	#18	12H	FFFFB4H			
Input capture 1	△	#19	13H	FFFFB0H	ICR04	0000B4H*1	
DTP/ external interrupt - ch.2/ch.3 detected	△	#20	14H	FFFFACH			
Input capture 2	△	#21	15H	FFFFA8H	ICR05	0000B5H*1	
Reload timer 3	△	#22	16H	FFFFA4H			
Input capture 3/4/5/6/7	△	#23	17H	FFFFA0H	ICR06	0000B6H*1	
DTP/ external interrupt - ch.4/ ch.5 detected UART3 RX	△	#24	18H	FFFF9CH			
PPG timer 0	△	#25	19H	FFFF98H	ICR07	0000B7H*1	
DTP/ external interrupt - ch.6/ ch.7 detected UART3 TX	△	#26	1AH	FFFF94H			
PPG timer 1	△	#27	1BH	FFFF90H	ICR08	0000B8H*1	
Reload timer 1	△	#28	1CH	FFFF8CH			
PPG timer 2/3/4/5	○	#29	1DH	FFFF88H	ICR09	0000B9H*1	
Real time watch timer watch timer (sub clock)	×	#30	1EH	FFFF84H			
Free-run timer overflow/clear	×	#31	1FH	FFFF80H	ICR10	0000BAH *1	
A/D converter conversion complete	○	#32	20H	FFFF7CH			
Sound generator 0/1	×	#33	21H	FFFF78H	ICR11	0000BBH*1	
Time-base timer	×	#34	22H	FFFF74H			
UART2 RX	○	#35	23H	FFFF70H	ICR12	0000BCH*1	
UART2 TX	△	#36	24H	FFFF6CH			Low

(Continued)

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Interrupt source	EI²OS corresponding	Interrupt vector			Interrupt control register		Priority *2
		Number		Address	ICR	Address	
UART 1 RX	◎	#37	25H	FFFF68H	ICR13	0000BDH*1	High
UART 1 TX	△	#38	26H	FFFF64H			
UART 0 RX	◎	#39	27H	FFFF60H	ICR14	0000BEH*1	
UART 0 TX	△	#40	28H	FFFF5CH			
Flash memory status	×	#41	29H	FFFF58H	ICR15	0000BFH*1	
Delay interrupt generator module	×	#42	2AH	FFFF54H			Low

◎ : Usable, and has expanded intelligent I/O services (EI²OS) stop function
○ : Usable
△ : Usable when interrupt sources sharing ICR are not in use
× : Unusable

*1 : • Peripheral functions that share the ICR register have the same interrupt level.
• If the expanded intelligent I/O service (EI²OS) is used with peripheral functions that share the ICR register, only one of the peripheral functions that share the register can be used.
• When the expanded intelligent I/O service (EI²OS) is specified for one of the peripheral functions that shares the ICR register, interrupts cannot be used from the other peripheral functions that share the register.

*2 : Priority applies when interrupts of the same level are generated.

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	
	AV_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	$AV_{CC} = V_{CC}$*2
	AVRH	V_{SS} – 0.3	V_{SS} + 6.0	V	$AV_{CC} \geq$ AVRH*2
	DV_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	$DV_{CC} = V_{CC}$*2
Input voltage*1	V_I	V_{SS} – 0.3	V_{CC} + 0.3	V	*3
Output voltage*1	V_O	V_{SS} – 0.3	V_{CC} + 0.3	V	
Maximum clamp current	I_{CLAMP}	– 4	+ 4	mA	*7
Total maximum clamp current	$\Sigma \lvert I_{CLAMP} \rvert$	—	40	mA	*7
"L" level maximum output current*4	I_{OL1}	—	15	mA	Except P70 to P77 and P80 to P87
	I_{OL2}	—	40	mA	P70 to P77 and P80 to P87
"L" level average output current*5	I_{OLAV1}	—	4	mA	Except P70 to P77 and P80 to P87
	I_{OLAV2}	—	30	mA	P70 to P77 and P80 to P87
"L" level maximum total output current	ΣI_{OL1}	—	100	mA	Except P70 to P77 and P80 to P87
	ΣI_{OL2}	—	330	mA	P70 to P77 and P80 to P87
"L" level average total output current	ΣI_{OLAV1}	—	50	mA	Except P70 to P77 and P80 to P87
	ΣI_{OLAV2}	—	250	mA	P70 to P77 and P80 to P87
"H" level maximum output current	I_{OH1}*4	—	–15	mA	Except P70 to P77 and P80 to P87
	I_{OH2}*4	—	–40	mA	P70 to P77 and P80 to P87
"H" level average output current	I_{OHAV1}*5	—	–4	mA	Except P70 to P77 and P80 to P87
	I_{OHAV2}*5	—	–30	mA	P70 to P77 and P80 to P87
"H" level maximum total output current	ΣI_{OH1}	—	–100	mA	Except P70 to P77 and P80 to P87
	ΣI_{OH2}	—	–330	mA	P70 to P77 and P80 to P87
"H" level average total output current	ΣI_{OHAV1}*6	—	–50	mA	Except P70 to P77 and P80 to P87
	ΣI_{OHAV2}*6	—	–250	mA	P70 to P77 and P80 to P87
Power consumption	P_D	—	625	mW	
Operating temperature	T_A	– 40	+ 105	°C	
Storage temperature	T_{STG}	– 55	+ 150	°C	

*1 : The parameter is based on $V_{SS} = AV_{SS} = DV_{SS} = 0.0$ V.

*2 : AV_{CC}, AVRH must not exceed V_{CC}, and AVRH must not exceed AV_{CC}.
When using an evaluation product, DV_{CC} must not exceed V_{CC} (however, DV_{CC} can be set to a higher voltage than V_{CC} when using a Flash memory product).

*3 : If the input current or the maximum input current is limited using external components, I_{CLAMP} is the applicable rating instead of V_I.

*4 : Maximum output current is defined as the peak value of current through any one of the corresponding pins.

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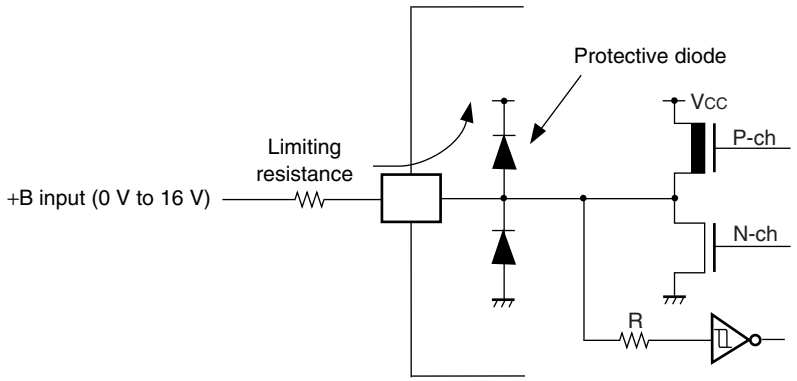
*5 : Average output current is defined as the average value of the current flowing through any one of the corresponding pins within a period of 100 ms. The “average value” can be calculated by multiplying the “operating current” by the “operating factor”.

*6 : Average total output current is defined as the average value of the current flowing through all of the corresponding pins within a period of 100 ms. The “average value” can be calculated by multiplying the “operating current” by the “ operating factor”.

*7 :
- Applicable to pins: P10 to P15,P50 to P57,P60 to P67,P70 to P77,P80 to P87,PC0 to PC7,PD0 to PD6, PE0 to PE2
- Use within recommended operating conditions.
- Use at DC voltage (current) .
- The +B signal should always be applied with a limiting resistance placed between the +B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the +B signal is applied, the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
- Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V) , the microcontroller may partially malfunction on power supplied through the +B signal pin.
- Note that if the +B input is applied during power-on, the power supply voltage may reach a level such that the power-on reset does not function due to the power supplied from the +B signal.
- Care must be taken not to leave +B input pins open.
- Note that analog system input/output pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal inputs.
- Sample recommended circuit :

- Input/output equivalent circuit



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

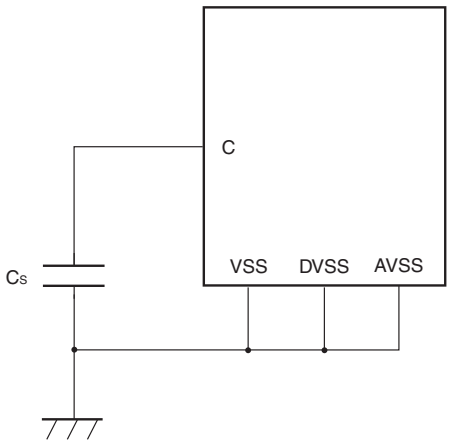
2. Recommended Operating Conditions

(V_{SS} = DV_{SS} = AV_{SS} = 0.0 V)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC} AV_{CC} DV_{CC}	4.0	5.5	V	The low voltage detection reset operates when the power supply voltage reaches 4.2 V ± 0.2 V.
		4.4	5.5	V	Maintain stop operation status The low voltage detection reset operates when the power supply voltage reaches 4.2 V ± 0.2 V.
Smoothing capacitor*	C_S	0.1	1.0	µF	Use a ceramic capacitor or other capacitor of equivalent frequency characteristics. Use a capacitor with a capacitance greater than this capacitor as the bypass capacitor for the V_{CC} pin.
Operating temperature	T_A	− 40	+ 105	°C	

* : Refer to the following diagram for details on the connection of the smoothing capacitor C_S.

• C pin connection diagram



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

3. DC Characteristics

(V_{CC} = 5.0 V ±10%, V_{SS} = DV_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IHA}	—	—	0.8 V_{CC}	—	—	V	Pin inputs if Automotive input levels are selected
	V_{IHS}	—	—	0.8 V_{CC}	—	—	V	Pin inputs if CMOS hysteresis input levels are selected
	V_{IHC}	—	—	0.7 V_{CC}	—	—	V	$\overline{RST}$ input pin (CMOS hysteresis)
"L" level input voltage	V_{ILA}	—	—	—	—	0.5 V_{CC}	V	Pin inputs if Automotive input levels are selected
	V_{ILS}	—	—	—	—	0.2 V_{CC}	V	Pin inputs if CMOS hysteresis input levels are selected
	V_{ILR}	—	—	—	—	0.3 V_{CC}	V	$\overline{RST}$ input pin (CMOS hysteresis)
Power supply current*	I_{CC}	V_{CC}	Maximum operating frequency F_{CP} = 32 MHz, normal operation	—	35	45	mA	
			Maximum operating frequency F_{CP} = 32 MHz, writing Flash memory	—	55	65	mA	
	I_{CCS}		Operating frequency F_{CP} = 32 MHz, sleep mode	—	13	20	mA	
	I_{CTS}		Operating frequency F_{CP} = 2 MHz, time-base timer mode	—	0.6	1.0	mA	
	I_{CTSPLL}		Operating frequency F_{CP} = 32 MHz, PLL timer mode, External frequency = 4 MHz	—	2.5	4	mA	
	I_{CCL}		Operating frequency F_{CP} = 8 kHz, T_A = + 25 °C, sub clock operation	—	120	270	µA	
	I_{CCLS}		Operating frequency F_{CP} = 8 kHz, T_A = + 25 °C, sub sleep operation	—	100	200	µA	
	I_{CCT}		Operating frequency F_{CP} = 8 kHz, T_A = + 25 °C, watch mode	—	90	180	µA	
	I_{CCH}		T_A = + 25 °C, stop mode	—	80	170	µA	

(Continued)

(V_{CC} = 5.0 V ±10%, V_{SS} = DV_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Input leakage current	I_{IL}	All input pins	V_{CC} = DV_{CC} = AV_{CC} = 5.5 V, V_{SS} < V_I < V_{CC}	—	—	10	µA	
Input capacitance 1	C_{IN1}	All pins except VCC, VSS, DVCC, DVSS, AVCC, AVSS, C, P70 to P77, P80 to P87	—	—	—	15	pF	
Input capacitance 2	C_{IN2}	P70 to P77, P80 to P87	—	—	—	45	pF	
Pull-up resistance	R_{UP}	$\overline{RST}$	—	25	50	100	kΩ	
Pull-down resistance	R_{DOWN}	MD2	—	—	—	100	kΩ	Excluding Flash memory product
General-purpose output “H” voltage	V_{OH1}	All pins except P70 to P77, P80 to P87	V_{CC} = 4.5 V, I_{OH} = –4.0 mA	V_{CC} – 0.5	—	—	V	
Stepping motor output “H” voltage	V_{OH2}	P70 to P77, P80 to P87	V_{CC} = 4.5 V, I_{OH} = –30.0 mA	V_{CC} – 0.5	—	—	V	
General-purpose output “L” voltage	V_{OL1}	All pins except P70 to P77, P80 to P87	V_{CC} = 4.5 V, I_{OL} = 4.0 mA	—	—	0.4	V	
Stepping motor output “L” voltage	V_{OL2}	P70 to P77, P80 to P87	V_{CC} = 4.5 V, I_{OL} = 30.0 mA	—	—	0.55	V	
Stepping motor output phase variation “H”	ΔV_{OH}	PWM1Pn, PWM1Mn, PWM2Pn, PWM2Mn, n = 0 to 3	V_{CC} = 4.5 V, I_{OH} = –30.0 mA, maximum deviation V_{OH2}	—	—	90	mV	
Stepping motor output phase variation “L”	ΔV_{OL}	PWM1Pn, PWM1Mn, PWM2Pn, PWM2Mn, n = 0 to 3	V_{CC} = 4.5 V, I_{OL} = 30.0 mA, maximum deviation V_{OH2}	—	—	90	mV	
LCD internal divider resistance	R_{LCD}	Between V0 and V1, Between V1 and V2, Between V2 and V3	—	50	100	200	kΩ	Evaluation product
				8.75	12.5	17.0	kΩ	Flash memory product

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(V_{CC} = 5.0 V ±10%, V_{SS} = DV_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
LCDC leakage current	I_{LCDC}	V0 to V3, COMm (m = 0 to 3) , SEGn, (n = 00 to 31)	—	—	—	5.0	µA	
LCD output impedance	Rvcom	COMn (n = 0 to 3)	—	—	—	4.5	kΩ	
	Rvseg	SEGn (n = 00 to 31)	—	—	—	17	kΩ	

* : Power supply current values assume an external clock supplied to the X1 pin and X1A pin. Users must be aware that power supply current levels differ depending on whether an external clock or oscillator is used.

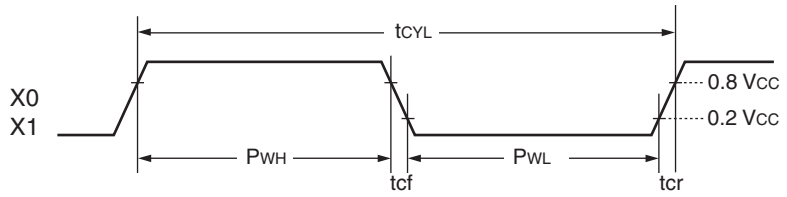
4. AC Characteristics

(1) Clock timing

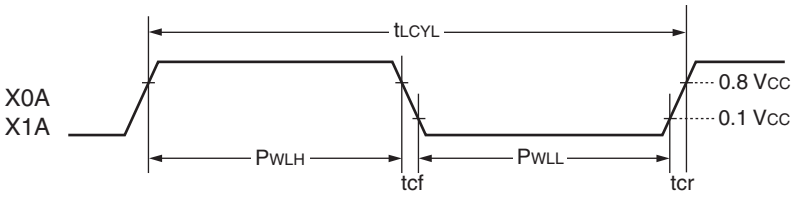
(V_{CC} = 5.0 V ±10%, V_{SS} = DV_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Clock frequency	F_C	X0, X1	—	3	—	16	MHz	1/2 (PLL stopped) When using the oscillator circuit
				3	—	32	MHz	1/2 (PLL stopped) When using an external clock
				4	—	32	MHz	PLL multiplied by 1
				3	—	16	MHz	PLL multiplied by 2
				3	—	10.7	MHz	PLL multiplied by 3
				3	—	8	MHz	PLL multiplied by 4
				3	—	5.33	MHz	PLL multiplied by 6
				3	—	4	MHz	PLL multiplied by 8
	F_{LC}	X0A, X1A		—	32.768	—	kHz	
Clock cycle time	t_{CYL}	X0, X1		62.5	—	333	ns	When using an oscillator
				31.25	—	333	ns	External clock input
	t_{LCYL}	X0A, X1A		—	30.5	—	µs	
Input clock pulse width	P_{WH}, P_{WL}	X0		5	—	—	ns	Use duty ratio of 50% ± 3% as a guideline
	P_{WLH}, P_{WLL}	X0A		—	15.2	—	µs	
Input clock rise and fall time	tcr, tcf	X0		—	—	5	ns	When using an external clock signal
Internal operating clock frequency	F_{CP}	—		1.5	—	32	MHz	Using main clock (PLL clock)
	F_{LCP}	—		—	8.192	—	kHz	Using sub clock
Internal operating clock cycle time	t_{CP}	—		31.25	—	666	ns	Using main clock (PLL clock)
	t_{LCP}	—		—	122.1	—	µs	Using sub clock

• X0, X1 clock timing

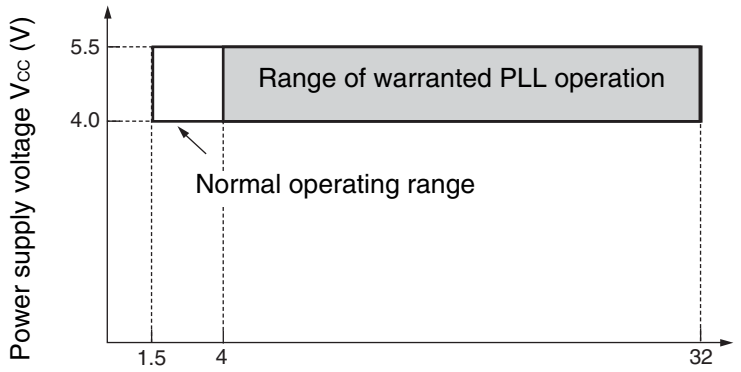


• X0A, X1A clock timing



• **Guaranteed PLL Operation Range**

Internal operating clock frequency vs. Power supply voltage



Notes : • For PLL 1 × only, use with tcp = 4 MHz or greater.
• Refer to “5. A/D Converter (1) Electrical Characteristics” for details on the A/D converter operating frequency.

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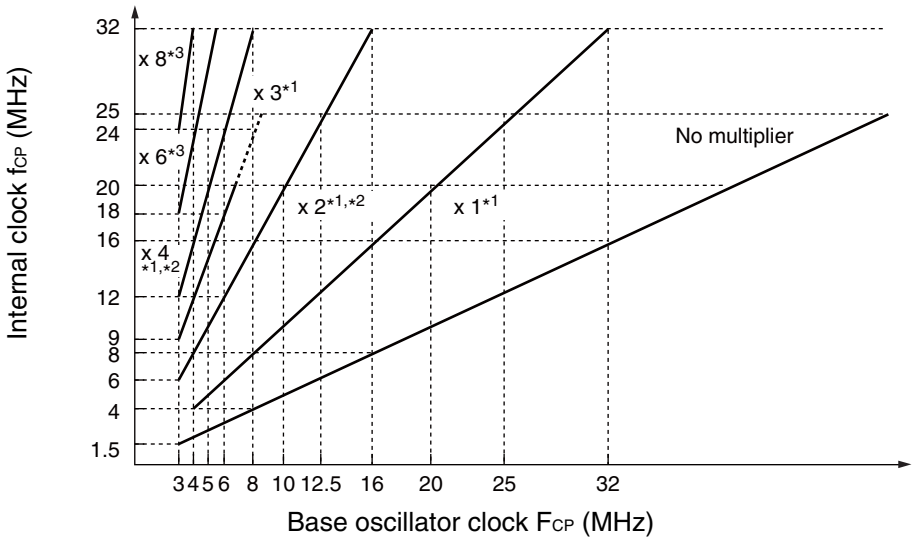
Base oscillator frequency vs. Internal operating clock frequency



*1 : When the PLL multiplier is × 1, × 2, × 3 or × 4 and the internal clock is 20 MHz < f_{CP} ≤ 32 MHz, set DIV2 bit = "1"*4, CS2 bit = "1" in the PSCCR register.
[Example] When using a base oscillator frequency of 24 MHz at PLL × 1 :
CKSCR register : CS1 bit = "0", CS0 bit = "0"
PSCCR register : DIV2 bit = "1"*4,CS2 bit = "1"
[Example] When using a base oscillator frequency of 6 MHz at PLL × 3 :
CKSCR register : CS1 bit = "1", CS0 bit = "0"
PSCCR register : DIV2 bit = "1"*4, CS2 bit = "1"

*2 : When the PLL multiplier is × 2 or × 4 and the internal clock is 20 MHz < f_{CP} ≤ 32 MHz, the following settings are also supported.
PLL × 2 : CKSCR register : CS1 bit = "0", CS0 bit = "0"
PSCCR register : DIV2 bit = "0"*4, CS2 bit = "0"
PLL × 4 : CKSCR register : CS1 bit = "0", CS0 bit = "1"
PSCCR register : DIV2 bit = "0"*4, CS2 bit = "0"

*3 : When the PLL multiplier is set to × 6 or × 8 set "DIV2 bit = "0"*4 CS2 bit = "1" and "PLL2 bit = 1" in the PSCCR register.
[Example] When using a base oscillator frequency of 4 MHz at PLL × 6 :
CKSCR register : CS1 bit = "1", CS0 bit = "0"
PLLOS register : DIV2 bit = "0"*4, CS2 bit = "1"
[Example] When using a base oscillator frequency of 3 MHz at PLL × 8 :
CKSCR register : CS1 bit = "1", CS0 bit = "1"
PLLOS register : DIV2 bit = "0"*4, CS2 bit = "1"

*4 : The DIV2 bit is assigned to bit 9 of the PSCCR register and the CS2 bit is assigned to bit 8 of the PSCCR register. Both bits have a default value of "0".

(2) Reset input

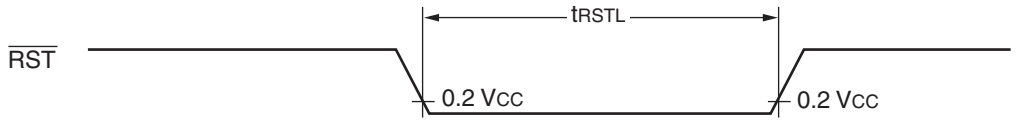
(V_{CC} = 5.0 V ±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

Parameter	Symbol	Pin name	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{RST}$	500	—	ns	During normal operation
			Oscillator oscillation time* + 16 t_{CP}	—	ms	In stop mode, sub clock mode, sub sleep mode, and watch mode
			100	—	µs	In time-base timer mode

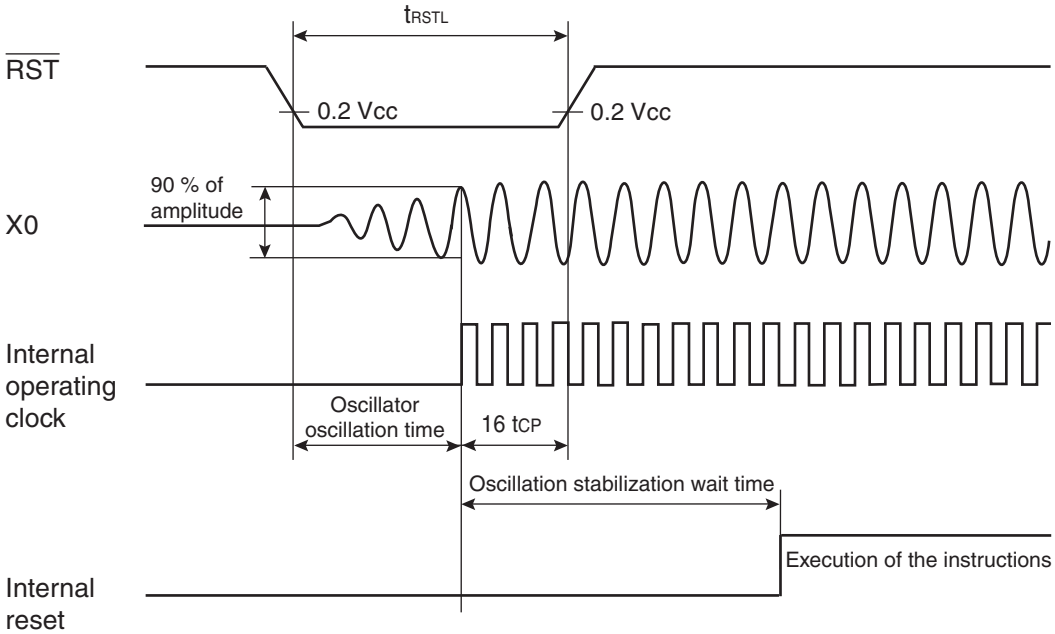
*: The oscillation time of the oscillator is the time taken to reach 90% of the amplitude. The oscillation time of a crystal oscillator is between several ms and tens of ms. The oscillation time of a ceramic oscillator is between hundreds of µs and several ms. The oscillation time of an external clock is 0 ms.

Note : t_{CP} is the internal operating clock cycle time. (Unit : ns)

• During normal operation



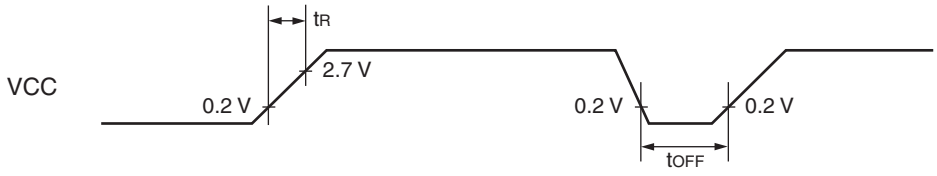
• In stop mode, sub clock mode, sub sleep mode, watch mode, and power-on



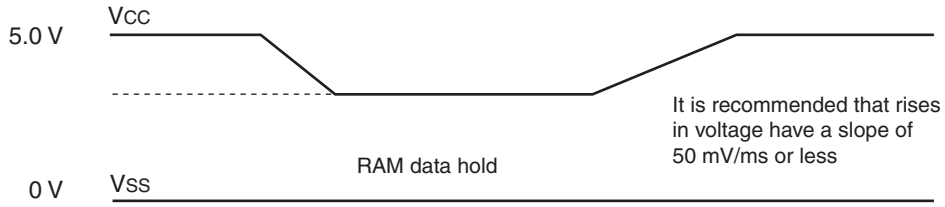
(3) Power-on reset

(V_{CC} = 2.7 V to 3.6 V, V_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Power supply rise time	t_R	VCC	—	0.05	30	ms	
Power off time	t_{OFF}			1	—	ms	Waiting time until power-on



Note : Extreme variations in power supply voltage may trigger a power-on reset. When the power supply voltage is changed during operation, it is recommended that increases in the voltage smoothed out as shown in the following diagram. The PLL clock of the device should not be in use when varying the voltage. However, the PLL clock may continue to be used if the rate of the voltage drop is 1 V/s or less.



(4) UART0/1/2/3 (LIN/SCI)

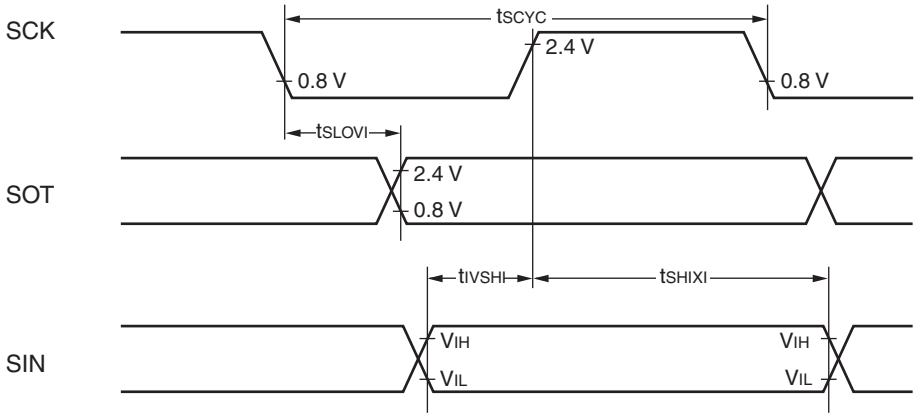
- **Bit setting: ESCR0/1/2/3:SCES=0, ECCR0/1/2/3:SCDE=0**

(V_{CC} = 5.0 V±10 %, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

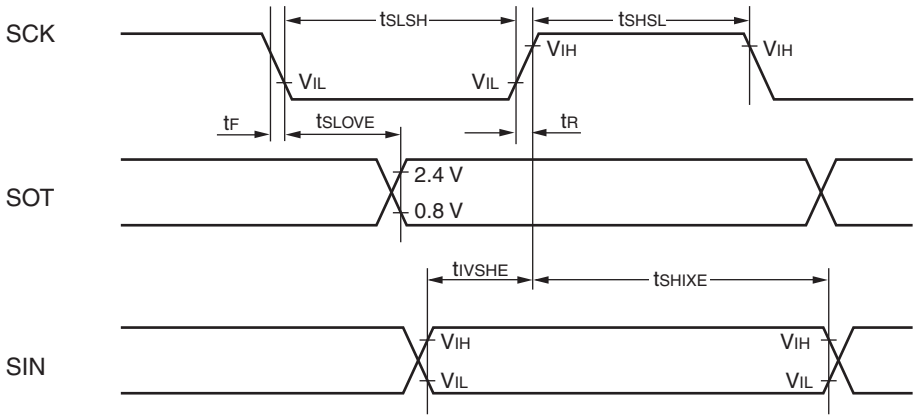
Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pin C_L = 80 pF + 1TTL	5 t_{CP}	—	ns
SCK ↓ → SOT delay time	t_{SLOVI}	SCK0 to SCK3, SOT0 to SOT3		− 50	+ 50	ns
Valid SIN → SCK ↑	t_{IVSHI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↑ → valid SIN hold time	t_{SHIXI}			0	—	ns
Serial clock “L” pulse width	t_{SLSH}	SCK0 to SCK3	External shift clock mode output pin C_L = 80 pF + 1TTL	3 t_{CP} − t_R	—	ns
Serial clock “H” pulse width	t_{SHSL}			t_{CP} + 10	—	ns
SCK ↓ → SOT delay time	t_{SLOVE}	SCK0 to SCK3, SOT0 to SOT3		—	2 t_{CP} + 60	ns
Valid SIN → SCK ↑	t_{IVSHE}	SCK0 to SCK3, SIN0 to SIN3		30	—	ns
SCK ↑ → valid SIN hold time	t_{SHIXE}			t_{CP} + 30	—	ns
SCK ↓ time	t_F	SCK0 to SCK3		—	10	ns
SCK ↑ time	t_R			—	10	ns

Notes : • Depending on the machine clock frequency to be used, the maximum baud rate may be limited by some parameters. These parameters are shown in “MB90920 series hardware manual”.
• C_L is the load capacitance connected to the pin during testing.
• t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.

- Internal shift clock mode



- External shift clock mode



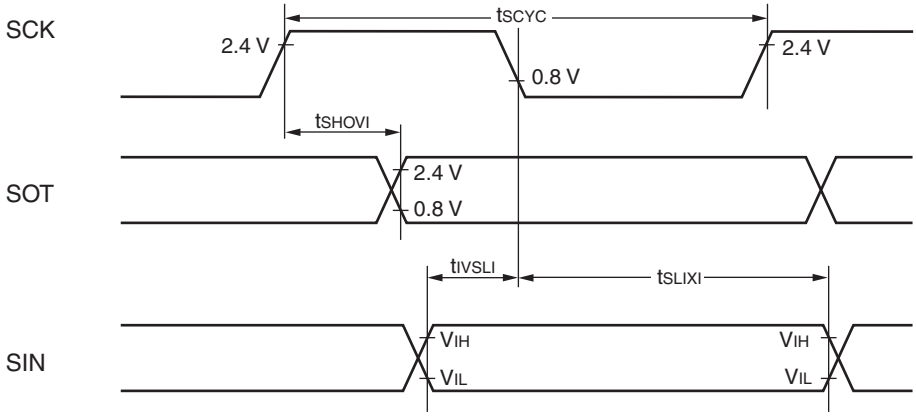
• **Bit setting: ESCR0/1/2/3:SCES=1, ECCR0/1/2/3:SCDE=0**

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

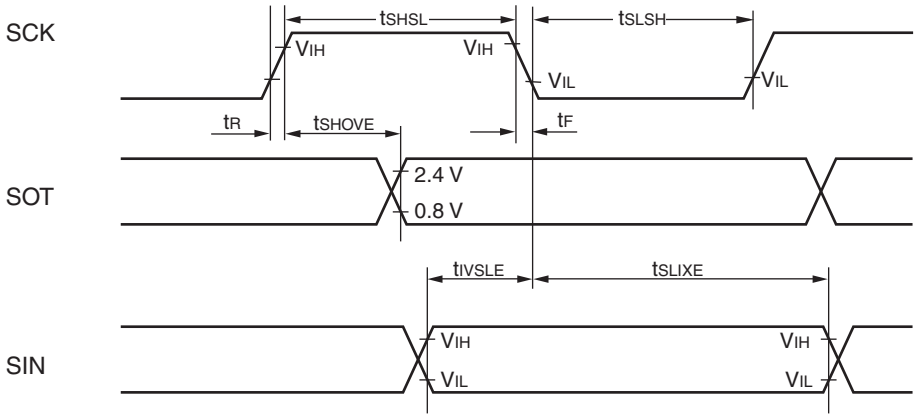
Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pin C_L = 80 pF + 1TTL	5 t_{CP}	—	ns
SCK ↑ → SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		− 50	+ 50	ns
Valid SIN → SCK ↓	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↓ → valid SIN hold time	t_{SLIXI}			0	—	ns
Serial clock “H” pulse width	t_{SHSL}	SCK0 to SCK3	External shift clock mode output pin C_L = 80 pF + 1TTL	3 t_{CP} − t_R	—	ns
Serial clock “L” pulse width	t_{SLSH}			t_{CP} + 10	—	ns
SCK ↑ → SOT delay time	t_{SHOVE}	SCK0 to SCK3, SOT0 to SOT3		—	2 t_{CP} + 60	ns
Valid SIN → SCK ↓	t_{IVSLE}	SCK0 to SCK3, SIN0 to SIN3		30	—	ns
SCK ↓ → valid SIN hold time	t_{SLIXE}			t_{CP} + 30	—	ns
SCK ↓ time	t_F	SCK0 to SCK3		—	10	ns
SCK ↑ time	t_R			—	10	ns

Notes : • Depending on the machine clock frequency to be used, the maximum baud rate may be limited by some parameters. These parameters are shown in “MB90920 series hardware manual”.
• C_L is the load capacitance connected to the pin during testing.
• t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.

- Internal shift clock mode



- External shift clock mode



• **Bit setting: ESCR0/1/2/3:SCES=0, ECCR0/1/2/3:SCDE=1**

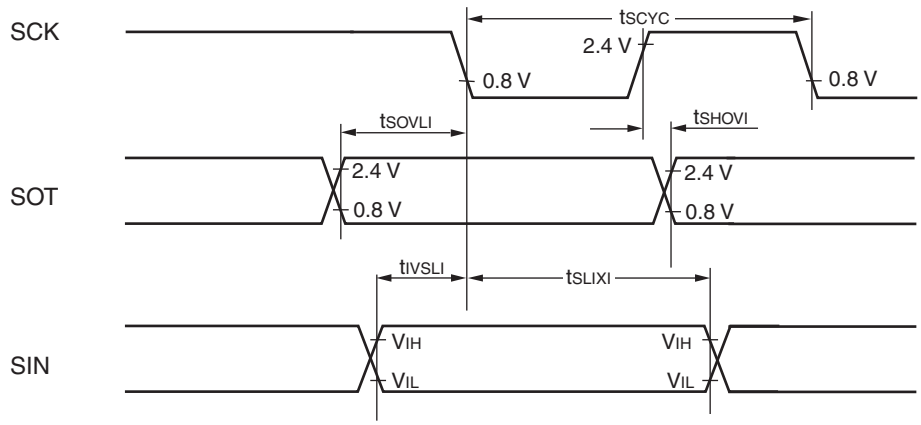
(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pin C_L = 80 pF + 1TTL	5 t_{CP}	—	ns
SCK ↑ → SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		– 50	+ 50	ns
Valid SIN → SCK ↓	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↓ → valid SIN hold time	t_{SLIXI}			0	—	ns
SOT → SCK ↓ delay time	t_{SOVLI}	SCK0 to SCK3, SOT0 to SOT3		3 t_{CP} – 70	—	ns

Notes : • Depending on the machine clock frequency to be used, the maximum baud rate may be limited by some parameters. These parameters are shown in “MB90920 series hardware manual”.

• C_L is the load capacitance connected to the pin during testing.

• t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.

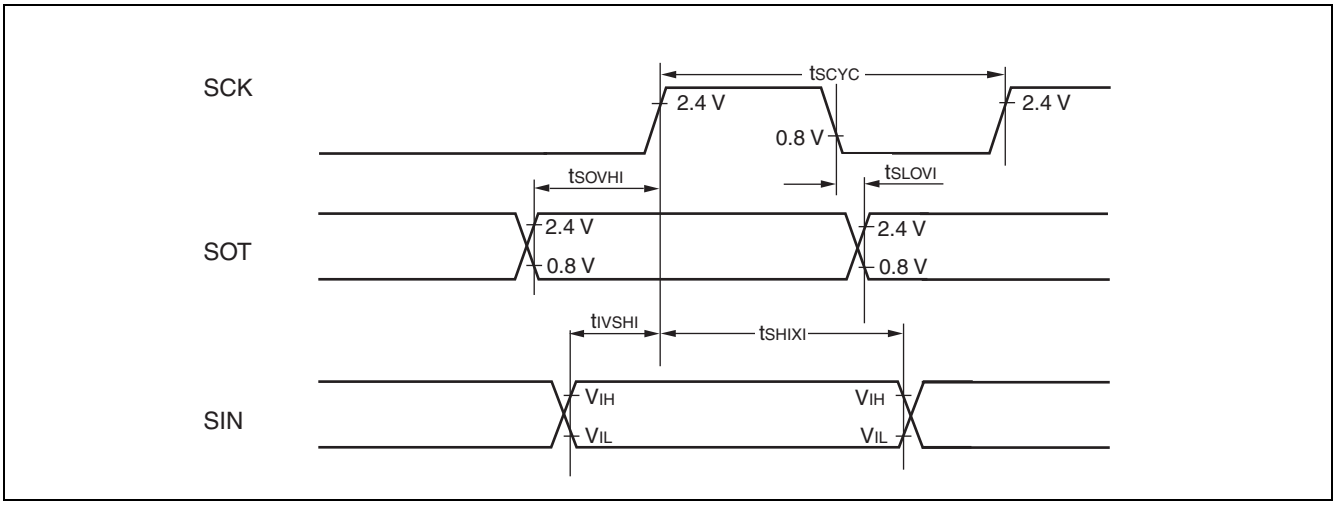


• **Bit setting: ESCR0/1/2/3:SCES=1, ECCR0/1/2/3:SCDE=1**

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pin C_L = 80 pF + 1TTL	5 t_{CP}	—	ns
SCK ↓ → SOT delay time	t_{SLOVI}	SCK0 to SCK3, SOT0 to SOT3		– 50	+ 50	ns
Valid SIN → SCK ↓	t_{IVSHI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↑ → valid SIN hold time	t_{SHIXI}			0	—	ns
SOT → SCK ↑ delay time	t_{SOVHI}	SCK0 to SCK3, SOT0 to SOT3		3 t_{CP} – 70	—	ns

Notes :
- Depending on the machine clock frequency to be used, the maximum baud rate may be limited by some parameters. These parameters are shown in “MB90920 series hardware manual”.
- C_L is the load capacitance connected to the pin during testing.
- t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.



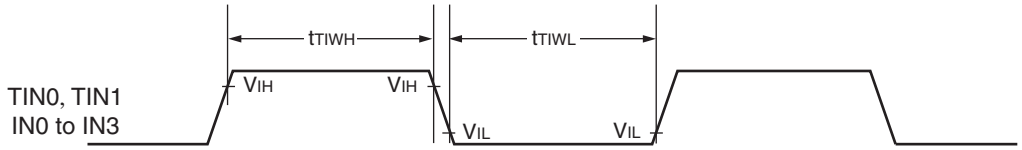
(5) Timer input timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Input pulse width	t_{TIWH} t_{TIWL}	TIN0, TIN1, IN0 to IN3	—	4 t_{CP}	—	ns

Note : t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.

- Timer input timing



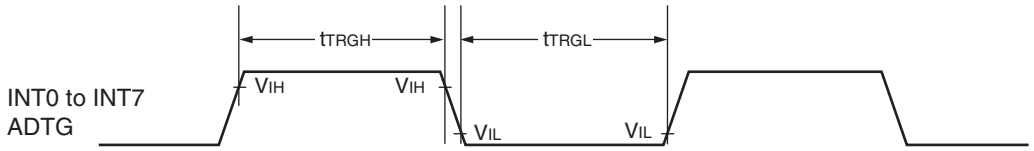
(6) Trigger input timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH}, t_{TRGL}	INT0 to INT7	—	200	—	ns	During normal operation
		ADTG	—	t_{CP} + 200	—	ns	

Note : t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.

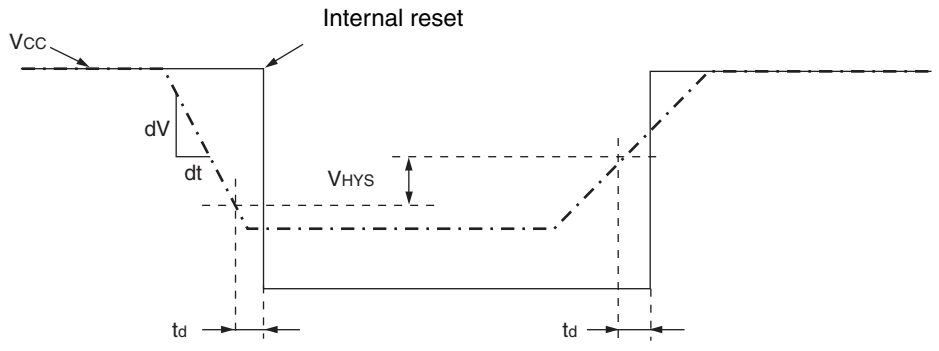
- Trigger input timing



(7) Low voltage detection

(V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Detection voltage	V_{DL}	VCC	—	4.0	4.2	4.4	V	Flash memory product, during voltage drop
				3.7	4.0	4.3	V	Evaluation product, during voltage drop
Hysteresis width	V_{HYS}	VCC	—	190	—	—	mV	Flash memory product, during voltage rise
				0.1	—	—	V	Evaluation product, during voltage rise
Power supply voltage change rate	dV/dt	VCC	—	– 0.1	—	+ 0.1	V/µs	Flash memory product, dV/dt at low voltage reset
				–0.004	—	+ 0.004	V/µs	Flash memory product, dV/dt at standard value of low voltage detection/release voltage
				– 0.1	—	+ 0.02	V/µs	Evaluation product
Detection delay time	td	—	—	—	—	3.2	µs	Flash memory product, when dV/dt ≤ 0.004 V/µs
				—	—	35	µs	Evaluation product



5. A/D Converter

(1) Electrical Characteristics

(V_{CC} = AV_{CC} = AVRH = 4.0 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Total error	—	—	– 3.0	—	+ 3.0	LSB	
Non-linear error	—	—	– 2.5	—	+ 2.5	LSB	
Differential linear error	—	—	– 1.9	—	+ 1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	AV_{SS} – 1.5 LSB	AV_{SS} + 0.5 LSB	AV_{SS} + 2.5 LSB	V	1 LSB = (AVRH – AV_{SS}) / 1024
Full scale transition voltage	V_{FST}	AN0 to AN7	AVRH – 3.5 LSB	AVRH – 1.5 LSB	AVRH + 0.5 LSB	V	
Sampling time	t_{SMP}	—	0.4	—	16500	µs	4.5 V ≤ AVcc ≤ 5.5 V
			1.0				4.0 V ≤ AVcc ≤ 4.5 V
Compare time	t_{CMP}	—	0.66	—	—	µs	4.5 V ≤ AVcc ≤ 5.5 V
			2.2				4.0 V ≤ AVcc ≤ 4.5 V
A/D conversion time	t_{CNV}	—	1.44	—	—	µs	*1
Analog port input current	I_{AIN}	AN0 to AN7	– 0.3	—	+ 10	µA	
Analog input voltage	V_{AIN}	AN0 to AN7	0	—	AVRH	V	
Reference voltage	AV+	AVRH	AVss + 2.7	—	AV_{CC}	V	
Power supply current	I_A	AV_{CC}	—	2.3	6.0	mA	
	I_{AH}		—	—	5	µA	*2
Reference voltage supply current	I_R	AVRH	—	520	900	µA	V_{AVRH} = 5.0 V
	I_{RH}		—	—	5	µA	*2
Inter-channel variation	—	AN0 to AN7	—	—	4	LSB	

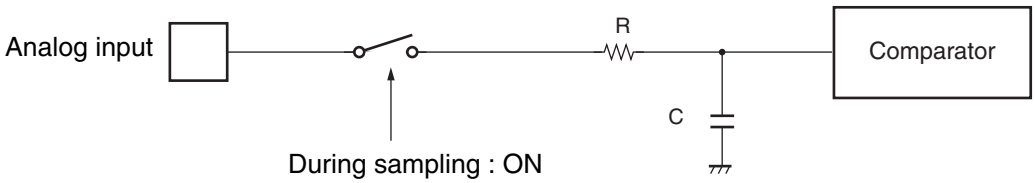
*1 : The time per channel (4.5 V ≤ AV_{CC} ≤ 5.5 V, and internal operating frequency = 32 MHz) .

*2 : Defined as supply current (when V_{CC} = AV_{CC} = AVRH = 5.0 V) with A/D converter not operating, and CPU in stop mode.

• **Notes on the external impedance and sampling time of analog inputs**

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. If the sampling time is still not sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• Analog input equivalent circuit



MB90F922NC/F922NCS/ F923NC/F923NCS/F924NC/F924NCS
MB90922NCS

	R	C
4.5 V ≤ AVcc ≤ 5.5 V :	2.6 kΩ (Max)	8.5 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	12.1 kΩ (Max)	8.5 pF (Max)

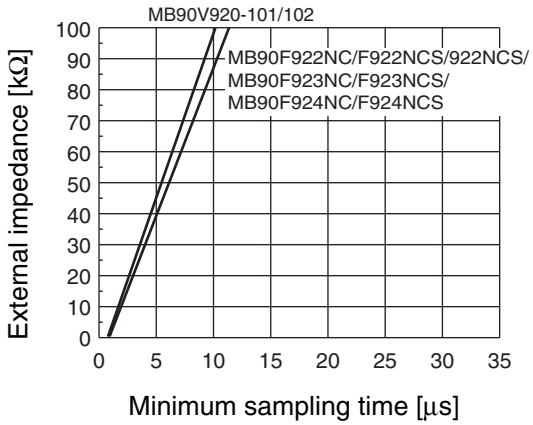
MB90V920-101/102

4.5 V ≤ AVcc ≤ 5.5 V :	2.0 kΩ (Max)	14.4 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	8.2 kΩ (Max)	14.4 pF (Max)

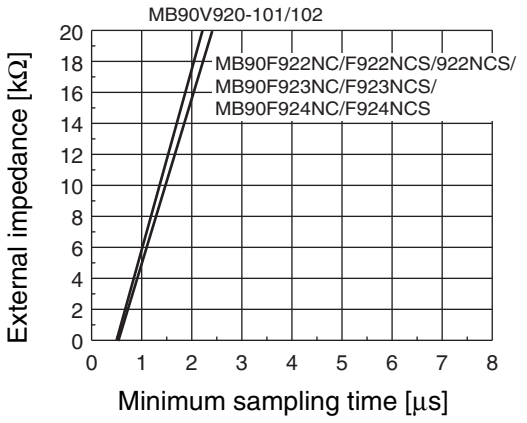
Note : The values are reference values.

- The relationship between the external impedance and minimum sampling time
- At 4.5 V ≤ AVcc ≤ 5.5 V

(External impedance = 0 kΩ to 100 kΩ)

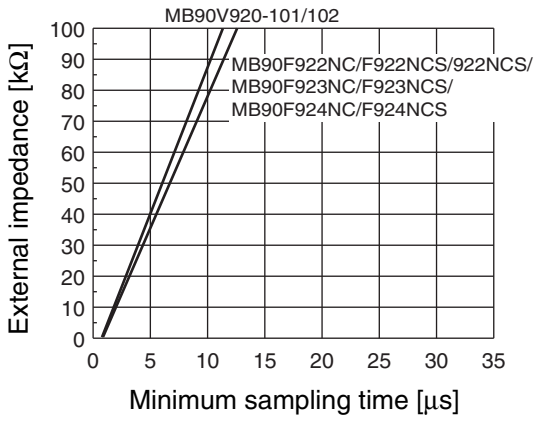


(External impedance = 0 kΩ to 20 kΩ)

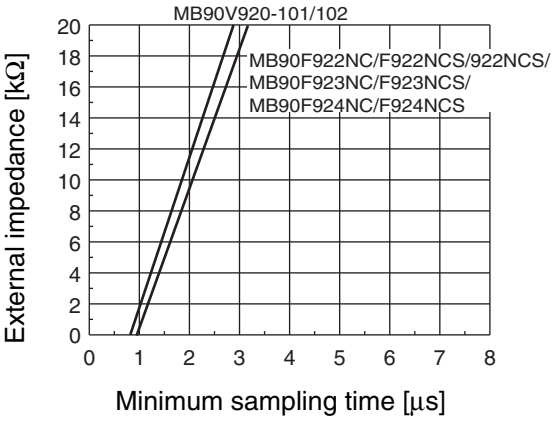


- At 4.0 V ≤ AVcc ≤ 4.5 V

(External impedance = 0 kΩ to 100 kΩ)



(External impedance = 0 kΩ to 20 kΩ)



- About errors
  As |AVRH - AVSS| becomes smaller, the relative errors grow larger.

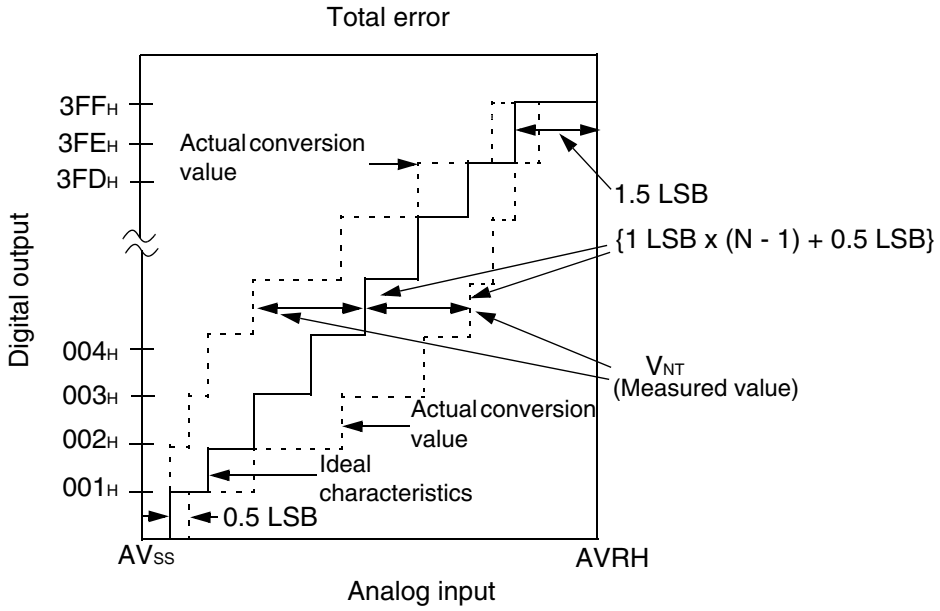
(2) Definition of terms

Resolution : Analog changes that are identifiable by the A/D converter.

Non-Linear error : The deviation of the straight line connecting the zero transition point ("00 0000 0000" ←→ "00 0000 0001") with the full-scale transition point ("11 1111 1110" ←→ "11 1111 1111") from actual conversion characteristics.

Differential linear error : The deviation from the ideal value of the input voltage needed to change the output code by 1 LSB.

Total error : The total error is the difference between the actual value and the theoretical value, and includes zero-transition error/full-scale transition error and linear error.



$$\text{Total error for digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + 0.5\ \text{LSB}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$1\ \text{LSB (Ideal)} = \frac{AVRH - AV_{SS}}{1024}\ [\text{V}]$$

N : A/D converter digital output value

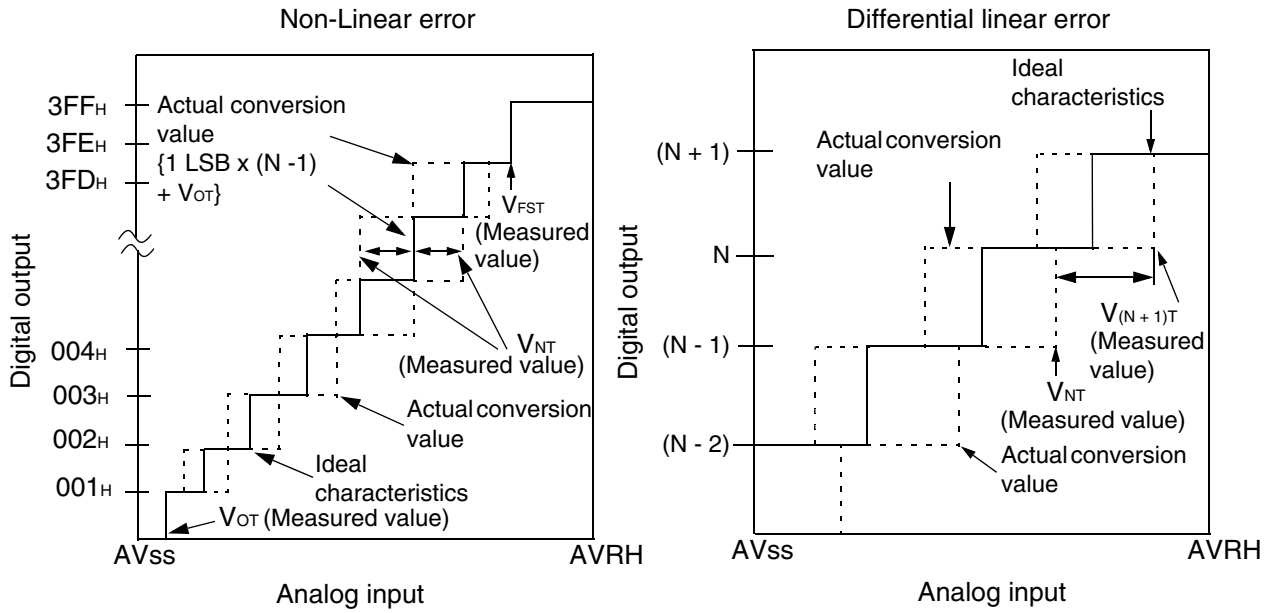
V_{OT} (Ideal) = AVss + 0.5 LSB [V]

V_{FST} (Ideal) = AVRH − 1.5 LSB [V]

V_{NT} : Voltage when the digital output changes from (N - 1) to N

(Continued)

(Continued)



$$\text{Non-linear error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + V_{OT}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$\text{Differential linear error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\ [\text{LSB}]$$

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ [\text{V}]$$

N : A/D converter digital output value
V_{OT} : Voltage when digital output changes from 000_H to 001_H
V_{FST} : Voltage when digital output changes from $3FE_H$ to $3FF_H$

6. Flash Memory Program/Erase Characteristics

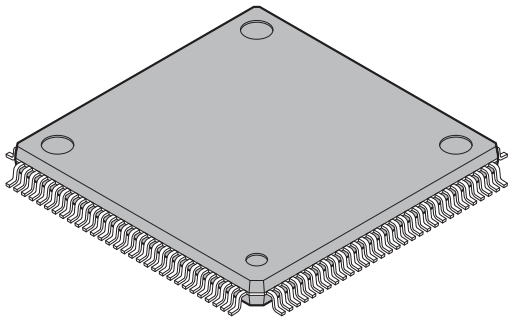
Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	T_A = + 25 °C V_{CC} = 5.0 V	—	0.9	3.6	s	Excludes pre-programming before erase
Word (16-bit width) programming time		—	23	370	µs	Excludes system-level overhead
Chip programming time	T_A = + 25 °C, V_{CC} = 5.0 V	—	3.4	55	s	
Erase/program cycle	—	10000	—	—	cycle	
Flash memory data retention time	Average T_A = + 85 °C	20	—	—	year	*

* : This value is calculated from the results of evaluating the reliability of the technology (using Arrhenius equation to translate high temperature measurements into normalized value at + 85 °C) .

■ ORDERING INFORMATION

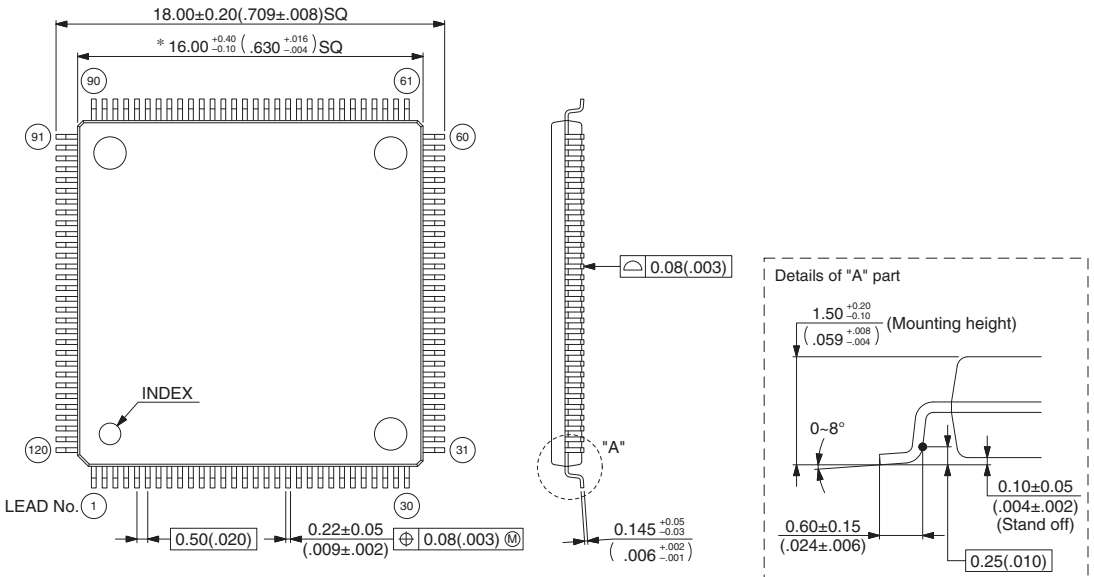
Part number	Package	Remarks
MB90F922NCPMC MB90F922NCSPMC MB90922NCSPMC MB90F923NCPMC MB90F923NCSPMC MB90F924NCPMC MB90F924NCSPMC	120-pin plastic LQFP (FPT-120P-M21)	
MB90V920-101CR MB90V920-102CR	299-pin ceramic PGA (PGA-299C-A01)	For evaluation

■ PACKAGE DIMENSION

120-pin plastic LQFP		
	Lead pitch	0.50 mm
	Package width × package length	16.0 × 16.0 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.70 mm MAX
	Weight	0.88 g
(FPT-120P-M21)	Code (Reference)	P-LFQFP120-16×16-0.50

120-pin plastic LQFP
(FPT-120P-M21)

Note 1) * : These dimensions do not include resin protrusion.
Resin protrusion is +0.25(.010) MAX(each side).
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.



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Dimensions in mm (inches).
Note: The values in parentheses are reference values.

Please check the latest package dimension at the following URL.
http://edevice.fujitsu.com/package/en-search/

■ MAJOR CHANGES IN THIS EDITION

Page	Section	Change Results
12	■I/O CIRCUIT TYPE	Corrected the circuit type B.
20	■ HANDLING DEVICES	Added the following items; • Serial communication • Characteristic difference between flash device and MASK ROM device
31	■ I/O MAP	Corrected “Address: 003970$_H$”. Clock supervisor control register → (Disabled)
46	■ ELECTRICAL CHARACTERISTICS 3. DC Characteristics	Added the item for “LCD output impedance”.
68	■ ORDERING INFORMATION	Corrected the part numbers; MB90V920-101 → MB90V920-101CR MB90V920-102 → MB90V920-102CR

The vertical lines marked in the left side of the page show the changes.

MEMO

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